

## One Microamp Supply-Current, +3V to +5.5V, 250kbps, RS-232 Transmitters/Receivers

The Intersil ICL32XX devices are 3.0V to 5.5V powered RS-232 transmitters/receivers which meet EIA/TIA-232 and V.28/V.24 specifications, even at  $V_{CC} = 3.0V$ . Targeted applications are PDAs, Palmtops, and notebook and laptop computers where the low operational, and even lower standby, power consumption is critical. Efficient on-chip charge pumps, coupled with manual and automatic powerdown functions (except for the ICL3232), reduce the standby supply current to a  $1\mu A$  trickle. Small footprint packaging, and the use of small, low value capacitors ensure board space savings as well. Data rates greater than 250kbps are guaranteed at worst case load conditions. This family is fully compatible with 3.3V only systems, mixed 3.3V and 5.0V systems, and 5.0V only systems.

The ICL324X are 3-driver, 5-receiver devices that provide a complete serial port suitable for laptop or notebook computers. Both devices also include noninverting always-active receivers for "wake-up" capability.

The **ICL3221, ICL3223 and ICL3243**, feature an **automatic powerdown** function which powers down the on-chip power-supply and driver circuits. This occurs when an attached peripheral device is shut off or the RS-232 cable is removed, conserving system power automatically without changes to the hardware or operating system. These devices power up again when a valid RS-232 voltage is applied to any receiver input.

Table 1 summarizes the features of the devices represented by this data sheet, while Application Note AN9863 summarizes the features of each device comprising the ICL32XX 3V family.

## Features

- Pb-Free Plus Anneal Available as an Option (RoHS Compliant) (See Ordering Info)
- 15kV ESD Protected (Human Body Model)
- Drop in Replacements for MAX3221, MAX3222, MAX3223, MAX3232, MAX3241, MAX3243, SP3243
- ICL3221 is Low Power, Pin Compatible Upgrade for 5V MAX221
- ICL3222 is Low Power, Pin Compatible Upgrade for 5V MAX242, and SP312A
- ICL3232 is Low Power Upgrade for HIN232/ICL232 and Pin Compatible Competitor Devices
- RS-232 Compatible with  $V_{CC} = 2.7V$
- Meets EIA/TIA-232 and V.28/V.24 Specifications at 3V
- Latch-Up Free
- On-Chip Voltage Converters Require Only Four External  $0.1\mu F$  Capacitors
- Manual and Automatic Powerdown Features (Except ICL3232)
- Guaranteed Mouse Driveability (ICL324X Only)
- Receiver Hysteresis For Improved Noise Immunity
- Guaranteed Minimum Data Rate . . . . . 250kbps
- Guaranteed Minimum Slew Rate . . . . .  $6V/\mu s$
- Wide Power Supply Range . . . . . Single +3V to +5.5V
- Low Supply Current in Powerdown State . . . . .  $1\mu A$

## Applications

- Any System Requiring RS-232 Communication Ports
  - Battery Powered, Hand-Held, and Portable Equipment
  - Laptop Computers, Notebooks, Palmtops
  - Modems, Printers and other Peripherals
  - Digital Cameras
  - Cellular/Mobile Phones

**TABLE 1. SUMMARY OF FEATURES**

| PART NUMBER | NO. OF Tx. | NO. OF Rx. | NO. OF MONITOR Rx. (ROUTB) | DATA RATE (kbps) | Rx. ENABLE FUNCTION? | READY OUTPUT? | MANUAL POWER-DOWN? | AUTOMATIC POWERDOWN FUNCTION? |
|-------------|------------|------------|----------------------------|------------------|----------------------|---------------|--------------------|-------------------------------|
| ICL3221     | 1          | 1          | 0                          | 250              | Yes                  | No            | Yes                | Yes                           |
| ICL3222     | 2          | 2          | 0                          | 250              | Yes                  | No            | Yes                | No                            |
| ICL3223     | 2          | 2          | 0                          | 250              | Yes                  | No            | Yes                | Yes                           |
| ICL3232     | 2          | 2          | 0                          | 250              | No                   | No            | No                 | No                            |
| ICL3241     | 3          | 5          | 2                          | 250              | Yes                  | No            | Yes                | No                            |
| ICL3243     | 3          | 5          | 1                          | 250              | No                   | No            | Yes                | Yes                           |

## Ordering Information

| PART NUMBER (NOTE 1) | PART MARKING | TEMP. RANGE (°C) | PACKAGE                  | PKG. DWG. # |
|----------------------|--------------|------------------|--------------------------|-------------|
| ICL3221CA            | ICL3221CA    | 0 to 70          | 16 Ld SSOP               | M16.209     |
| ICL3221CAZ (Note 2)  | ICL3221CAZ   | 0 to 70          | 16 Ld SSOP (Pb-free)     | M16.209     |
| ICL3221CV            | ICL3221CV    | 0 to 70          | 16 Ld TSSOP              | M16.173     |
| ICL3221CVZ (Note 2)  | 3221CVZ      | 0 to 70          | 16 Ld TSSOP (Pb-free)    | M16.173     |
| ICL3221IA            | ICL3221IA    | -40 to 85        | 16 Ld SSOP               | M16.209     |
| ICL3221IAZ (Note 2)  | ICL3221IAZ   | -40 to 85        | 16 Ld SSOP (Pb-free)     | M16.209     |
| ICL3222CA            | ICL3222CA    | 0 to 70          | 20 Ld SSOP               | M20.209     |
| ICL3222CAZ (Note 2)  | ICL3222CAZ   | 0 to 70          | 20 Ld SSOP (Pb-free)     | M20.209     |
| ICL3222CB            | ICL3222CB    | 0 to 70          | 18 Ld SOIC               | M18.3       |
| ICL3222CBZ (Note 2)  | 3222CBZ      | 0 to 70          | 18 Ld SOIC (Pb-free)     | M18.3       |
| ICL3222CP            | ICL3222CP    | 0 to 70          | 18 Ld PDIP               | E18.3       |
| ICL3222CPZ (Note 2)  | ICL3222CPZ   | 0 to 70          | 18 Ld PDIP* (Pb-free)    | E18.3       |
| ICL3222CV            | ICL3222CV    | 0 to 70          | 20 Ld TSSOP              | M20.173     |
| ICL3222CVZ (Note 2)  | ICL3222CVZ   | 0 to 70          | 20 Ld TSSOP (Pb-free)    | M20.173     |
| ICL3222IA            | ICL3222IA    | -40 to 85        | 20 Ld SSOP               | M20.209     |
| ICL3222IAZ (Note 2)  | ICL3222IAZ   | -40 to 85        | 20 Ld SSOP (Pb-free)     | M20.209     |
| ICL3222IB            | ICL3222IB    | -40 to 85        | 18 Ld SOIC               | M18.3       |
| ICL3222IV            | ICL3222IV    | -40 to 85        | 20 Ld TSSOP              | M20.173     |
| ICL3222IVZ (Note 2)  | ICL3222IVZ   | -40 to 85        | 20 Ld TSSOP (Pb-free)    | M20.173     |
| ICL3223CA            | ICL3223CA    | 0 to 70          | 20 Ld SSOP               | M20.209     |
| ICL3223CAZ (Note 2)  | ICL3223CAZ   | 0 to 70          | 20 Ld SSOP (Pb-free)     | M20.209     |
| ICL3223CP            | ICL3223CP    | 0 to 70          | 20 Ld PDIP               | E20.3       |
| ICL3223CPZ (Note 2)  | ICL3223CPZ   | 0 to 70          | 20 Ld PDIP* (Pb-free)    | E20.3       |
| ICL3223CV            | ICL3223CV    | 0 to 70          | 20 Ld TSSOP              | M20.173     |
| ICL3223IA            | ICL3223IA    | -40 to 85        | 20 Ld SSOP               | M20.209     |
| ICL3223IAZ (Note 2)  | ICL3223IAZ   | -40 to 85        | 20 Ld SSOP (Pb-free)     | M20.209     |
| ICL3223IV            | ICL3223IV    | -40 to 85        | 20 Ld TSSOP              | M20.173     |
| ICL3223IVZ (Note 2)  | ICL3223IVZ   | -40 to 85        | 20 Ld TSSOP (Pb-free)    | M20.173     |
| ICL3232CA            | ICL3232CA    | 0 to 70          | 16 Ld SSOP               | M16.209     |
| ICL3232CAZ (Note 2)  | 3232CAZ      | 0 to 70          | 16 Ld SSOP (Pb-free)     | M16.209     |
| ICL3232CB            | ICL3232CB    | 0 to 70          | 16 Ld SOIC               | M16.3       |
| ICL3232CBZ (Note 2)  | 3232CBZ      | 0 to 70          | 16 Ld SOIC (Pb-free)     | M16.3       |
| ICL3232CBN           | 3232CBN      | 0 to 70          | 16 Ld SOIC (N)           | M16.15      |
| ICL3232CBNZ (Note 2) | 3232CBNZ     | 0 to 70          | 16 Ld SOIC (N) (Pb-free) | M16.15      |
| ICL3232CP            | ICL3232CP    | 0 to 70          | 16 Ld PDIP               | E16.3       |
| ICL3232CPZ (Note 2)  | ICL3232CPZ   | 0 to 70          | 16 Ld PDIP* (Pb-free)    | E16.3       |
| ICL3232CV            | ICL3232CV    | 0 to 70          | 16 Ld TSSOP              | M16.173     |

**Ordering Information** (Continued)

| PART NUMBER (NOTE 1) | PART MARKING | TEMP. RANGE (°C) | PACKAGE                  | PKG. DWG. # |
|----------------------|--------------|------------------|--------------------------|-------------|
| ICL3232CVZ (Note 2)  | 3232CVZ      | 0 to 70          | 16 Ld TSSOP (Pb-free)    | M16.173     |
| ICL3232IA            | ICL3232IA    | -40 to 85        | 16 Ld SSOP               | M16.209     |
| ICL3232IAZ (Note 2)  | 3232IAZ      | -40 to 85        | 16 Ld SSOP (Pb-free)     | M16.209     |
| ICL3232IB            | ICL3232IB    | -40 to 85        | 16 Ld SOIC               | M16.3       |
| ICL3232IBZ (Note 2)  | 3232IBZ      | -40 to 85        | 16 Ld SOIC (Pb-free)     | M16.3       |
| ICL3232IBN           | 3232IBN      | -40 to 85        | 16 Ld SOIC (N)           | M16.15      |
| ICL3232IBNZ (Note 2) | 3232IBNZ     | -40 to 85        | 16 Ld SOIC (N) (Pb-free) | M16.15      |
| ICL3232IV            | ICL3232IV    | -40 to 85        | 16 Ld TSSOP              | M16.173     |
| ICL3232IVZ (Note 2)  | 3232IVZ      | -40 to 85        | 16 Ld TSSOP (Pb-free)    | M16.173     |
| ICL3241CA            | ICL3241CA    | 0 to 70          | 28 Ld SSOP               | M28.209     |
| ICL3241CAZ (Note 2)  | ICL3241CAZ   | 0 to 70          | 28 Ld SSOP (Pb-free)     | M28.209     |
| ICL3241CB            | ICL3241CB    | 0 to 70          | 28 Ld SOIC               | M28.3       |
| ICL3241CBZ (Note 2)  | ICL3241CBZ   | 0 to 70          | 28 Ld SOIC (Pb-free)     | M28.3       |
| ICL3241CV            | ICL3241CV    | 0 to 70          | 28 Ld TSSOP              | M28.173     |
| ICL3241CVZ (Note 2)  | ICL3241CVZ   | 0 to 70          | 28 Ld TSSOP (Pb-free)    | M28.173     |
| ICL3241IA            | ICL3241IA    | -40 to 85        | 28 Ld SSOP               | M28.209     |
| ICL3241IAZ (Note 2)  | ICL3241IAZ   | -40 to 85        | 28 Ld SSOP (Pb-free)     | M28.209     |
| ICL3241IB            | ICL3241IB    | -40 to 85        | 28 Ld SOIC               | M28.3       |
| ICL3241IBZ (Note 2)  | ICL3241IBZ   | -40 to 85        | 28 Ld SOIC (Pb-free)     | M28.3       |
| ICL3241IV            | ICL3241IV    | -40 to 85        | 28 Ld TSSOP              | M28.173     |
| ICL3241IVZ (Note 2)  | ICL3241IVZ   | -40 to 85        | 28 Ld TSSOP (Pb-free)    | M28.173     |
| ICL3243CA            | ICL3243CA    | 0 to 70          | 28 Ld SSOP               | M28.209     |
| ICL3243CAZ (Note 2)  | ICL3243CAZ   | 0 to 70          | 28 Ld SSOP (Pb-free)     | M28.209     |
| ICL3243CB            | ICL3243CB    | 0 to 70          | 28 Ld SOIC               | M28.3       |
| ICL3243CBZ (Note 2)  | ICL3243CBZ   | 0 to 70          | 28 Ld SOIC (Pb-free)     | M28.3       |
| ICL3243CV            | ICL3243CV    | 0 to 70          | 28 Ld TSSOP              | M28.173     |
| ICL3243CVZ (Note 2)  | ICL3243CVZ   | 0 to 70          | 28 Ld TSSOP (Pb-free)    | M28.173     |
| ICL3243IA            | ICL3243IA    | -40 to 85        | 28 Ld SSOP               | M28.209     |
| ICL3243IAZ (Note 2)  | ICL3243IAZ   | -40 to 85        | 28 Ld SSOP (Pb-free)     | M28.209     |

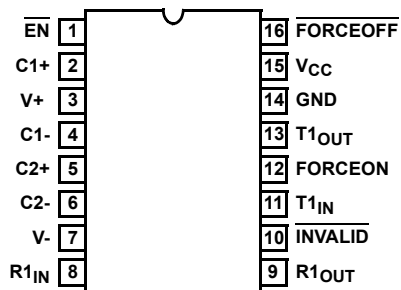
\*Pb-free PDIPs can be used for through hole wave solder processing only. They are not intended for use in Reflow solder processing applications.

**NOTES:**

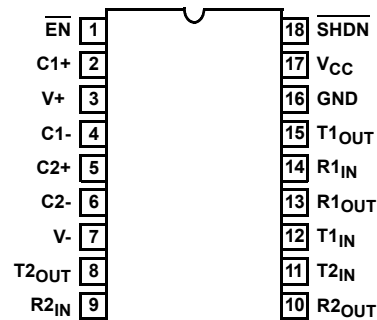
1. Most surface mount devices are available on tape and reel; add "-T" to suffix.
2. Intersil Pb-free plus anneal products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate termination finish, which are RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

## Pinouts

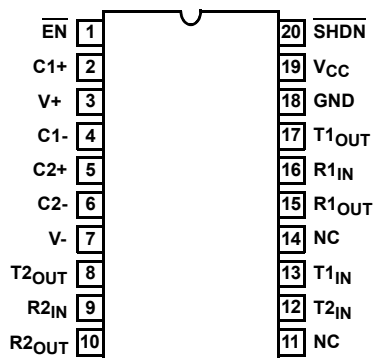
ICL3221 (SSOP, TSSOP)  
TOP VIEW



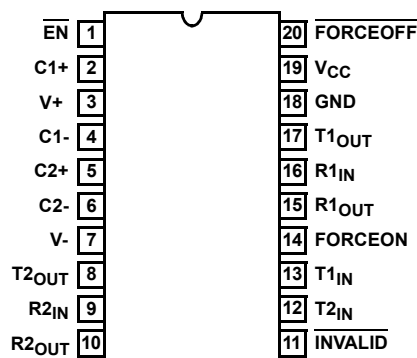
ICL3222 (PDIP, SOIC)  
TOP VIEW



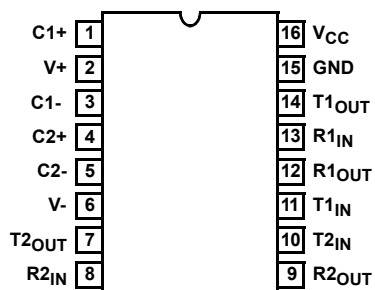
ICL3222 (SSOP, TSSOP)  
TOP VIEW



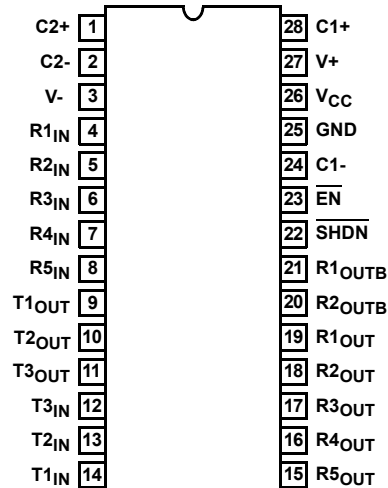
ICL3223 (PDIP, SSOP, TSSOP)  
TOP VIEW



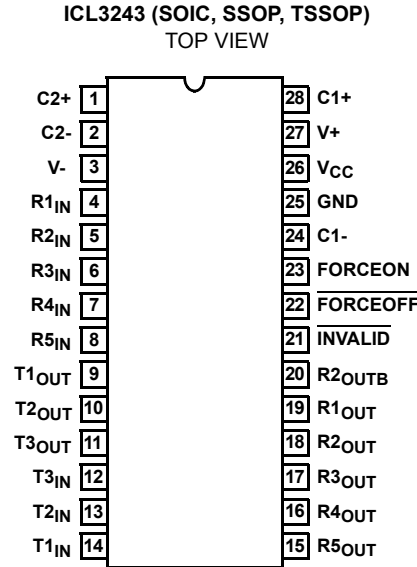
ICL3232 (PDIP, SOIC, SSOP, TSSOP)  
TOP VIEW



ICL3241 (SOIC, SSOP, TSSOP)  
TOP VIEW



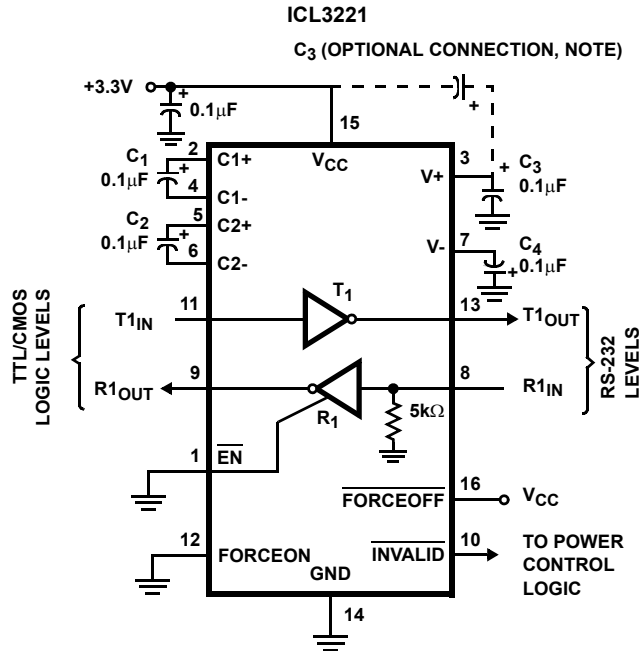
**Pinouts** (Continued)



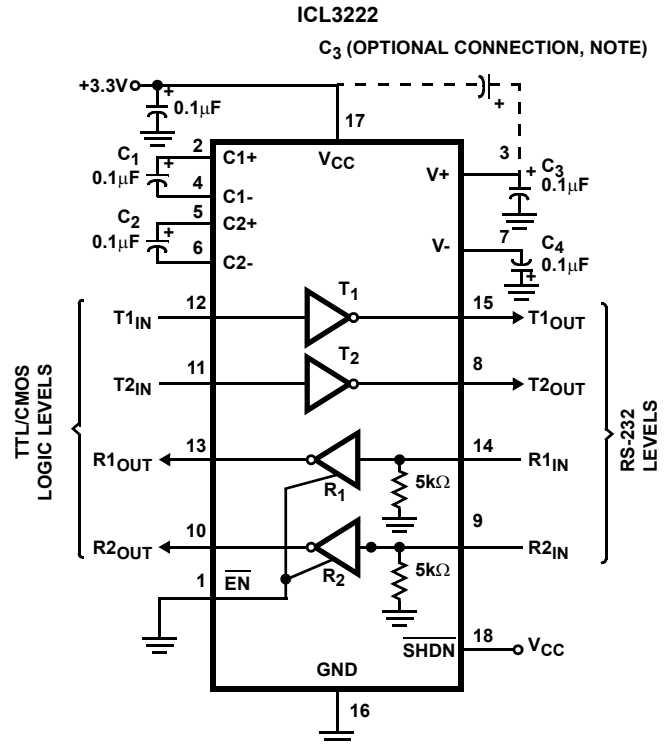
**Pin Descriptions**

| PIN                          | FUNCTION                                                                                                                                       |
|------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------|
| V <sub>CC</sub>              | System power supply input (3.0V to 5.5V).                                                                                                      |
| V+                           | Internally generated positive transmitter supply (+5.5V).                                                                                      |
| V-                           | Internally generated negative transmitter supply (-5.5V).                                                                                      |
| GND                          | Ground connection.                                                                                                                             |
| C1+                          | External capacitor (voltage doubler) is connected to this lead.                                                                                |
| C1-                          | External capacitor (voltage doubler) is connected to this lead.                                                                                |
| C2+                          | External capacitor (voltage inverter) is connected to this lead.                                                                               |
| C2-                          | External capacitor (voltage inverter) is connected to this lead.                                                                               |
| T <sub>IN</sub>              | TTL/CMOS compatible transmitter Inputs.                                                                                                        |
| T <sub>OUT</sub>             | RS-232 level (nominally ±5.5V) transmitter outputs.                                                                                            |
| R <sub>IN</sub>              | RS-232 compatible receiver inputs.                                                                                                             |
| R <sub>OUT</sub>             | TTL/CMOS level receiver outputs.                                                                                                               |
| R <sub>OUTB</sub>            | TTL/CMOS level, noninverting, always enabled receiver outputs.                                                                                 |
| INVALID                      | Active low output that indicates if no valid RS-232 levels are present on any receiver input.                                                  |
| $\overline{\text{EN}}$       | Active low receiver enable control; doesn't disable R <sub>OUTB</sub> outputs.                                                                 |
| $\overline{\text{SHDN}}$     | Active low input to shut down transmitters and on-board power supply, to place device in low power mode.                                       |
| $\overline{\text{FORCEOFF}}$ | Active low to shut down transmitters and on-chip power supply. This overrides any automatic circuitry and FORCEON (See Table 2).               |
| FORCEON                      | Active high input to override automatic powerdown circuitry thereby keeping transmitters active. ( $\overline{\text{FORCEOFF}}$ must be high). |

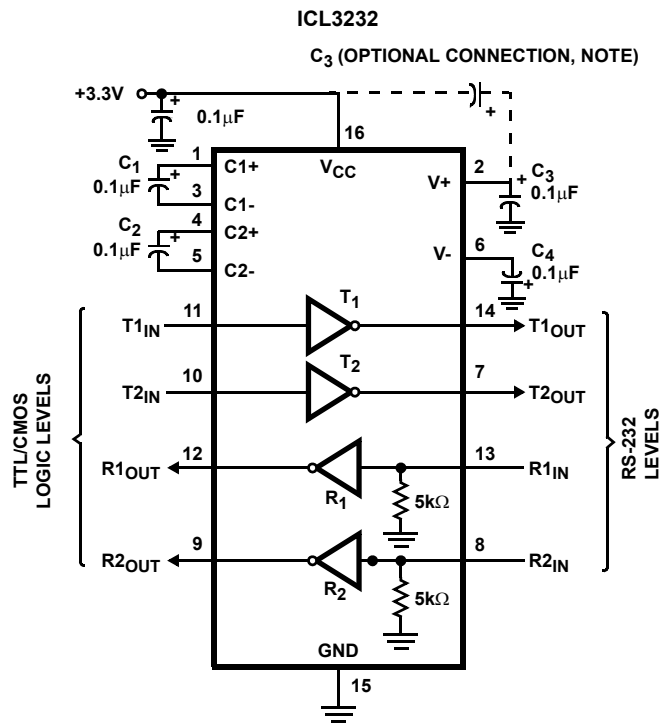
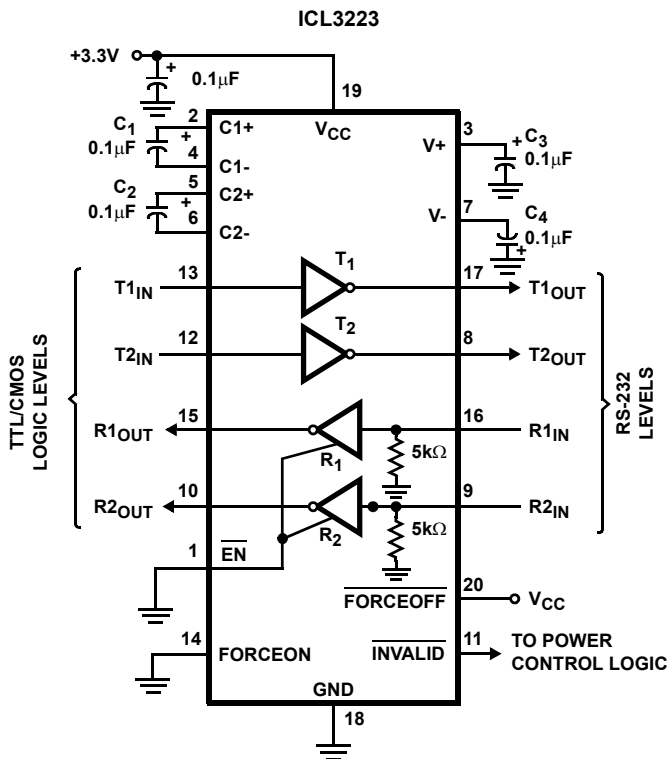
## Typical Operating Circuits



NOTE: The negative terminal of C<sub>3</sub> can be connected to either V<sub>CC</sub> or GND



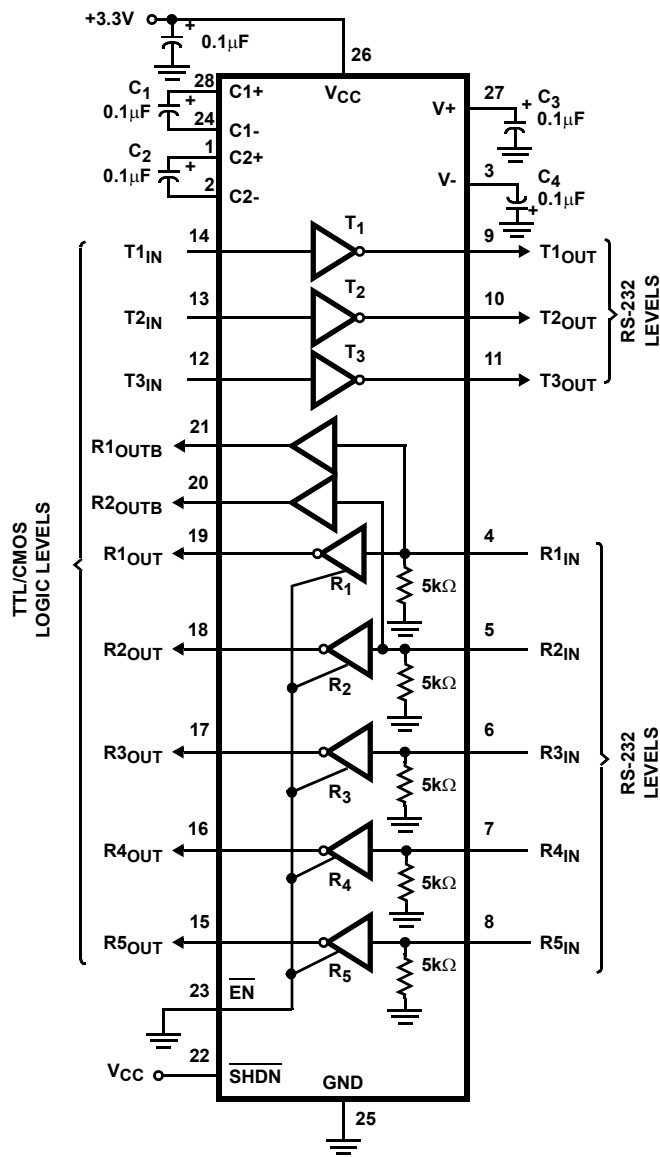
NOTE: The negative terminal of C<sub>3</sub> can be connected to either V<sub>CC</sub> or GND



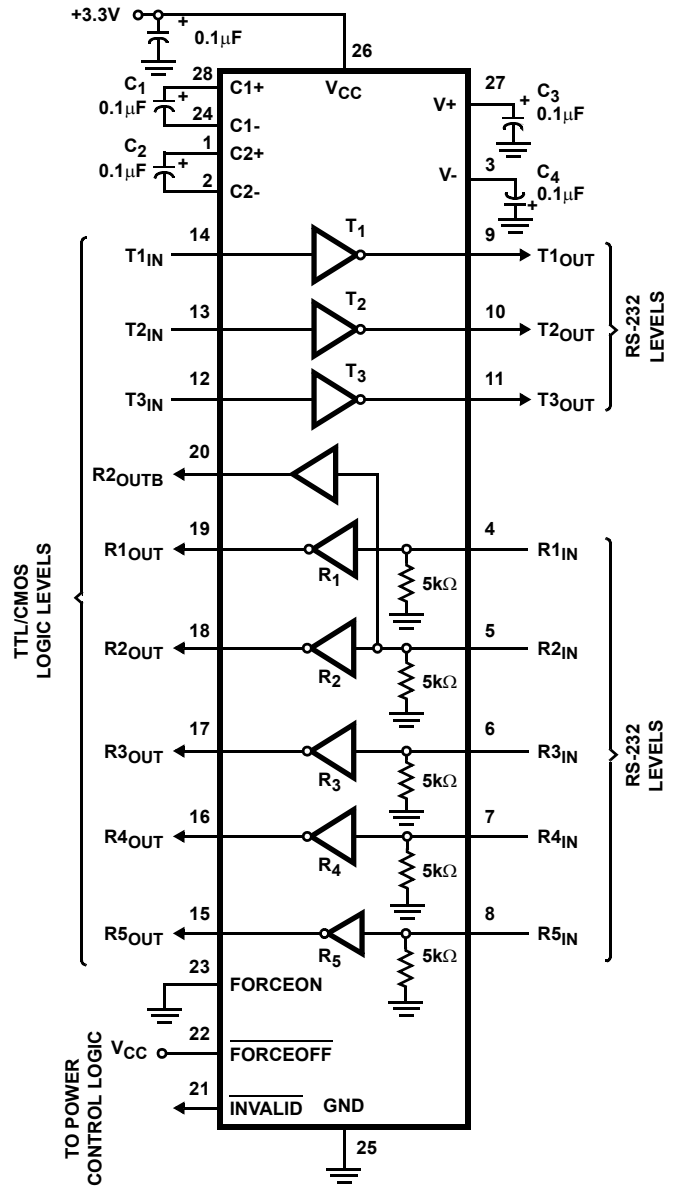
NOTE: The negative terminal of C<sub>3</sub> can be connected to either V<sub>CC</sub> or GND

Typical Operating Circuits (Continued)

ICL3241



ICL3243



# ICL3221, ICL3222, ICL3223, ICL3232, ICL3241, ICL3243

## Absolute Maximum Ratings

|                                                                                        |                                |
|----------------------------------------------------------------------------------------|--------------------------------|
| V <sub>CC</sub> to Ground                                                              | -0.3V to 6V                    |
| V <sub>+</sub> to Ground                                                               | -0.3V to 7V                    |
| V <sub>-</sub> to Ground                                                               | +0.3V to -7V                   |
| V <sub>+</sub> to V <sub>-</sub>                                                       | 14V                            |
| Input Voltages                                                                         |                                |
| T <sub>IN</sub> , FORCEOFF, FORCEON, $\overline{\text{EN}}$ , $\overline{\text{SHDN}}$ | -0.3V to 6V                    |
| R <sub>IN</sub>                                                                        | ±25V                           |
| Output Voltages                                                                        |                                |
| T <sub>OUT</sub>                                                                       | ±13.2V                         |
| R <sub>OUT</sub> , INVALID                                                             | -0.3V to V <sub>CC</sub> +0.3V |
| Short Circuit Duration                                                                 |                                |
| T <sub>OUT</sub>                                                                       | Continuous                     |
| ESD Rating                                                                             | See Specification Table        |

## Operating Conditions

|                   |               |
|-------------------|---------------|
| Temperature Range |               |
| ICL32XXCX         | 0°C to 70°C   |
| ICL32XXIX         | -40°C to 85°C |

## Thermal Information

|                                                                                                                                                  |                        |
|--------------------------------------------------------------------------------------------------------------------------------------------------|------------------------|
| Thermal Resistance (Typical, Note 3)                                                                                                             | θ <sub>JA</sub> (°C/W) |
| 16 Ld PDIP Package*                                                                                                                              | 90                     |
| 18 Ld PDIP Package*                                                                                                                              | 80                     |
| 20 Ld PDIP Package*                                                                                                                              | 77                     |
| 16 Ld Wide SOIC Package                                                                                                                          | 100                    |
| 16 Ld Narrow SOIC Package                                                                                                                        | 115                    |
| 18 Ld SOIC Package                                                                                                                               | 75                     |
| 28 Ld SOIC Package                                                                                                                               | 75                     |
| 16 Ld SSOP Package                                                                                                                               | 135                    |
| 20 Ld SSOP Package                                                                                                                               | 122                    |
| 16 Ld TSSOP Package                                                                                                                              | 145                    |
| 20 Ld TSSOP Package                                                                                                                              | 140                    |
| 28 Ld SSOP and TSSOP Packages                                                                                                                    | 100                    |
| Maximum Junction Temperature (Plastic Package)                                                                                                   | 150°C                  |
| Maximum Storage Temperature Range                                                                                                                | -65°C to 150°C         |
| Maximum Lead Temperature (Soldering 10s)                                                                                                         | 300°C                  |
| (SOIC, SSOP, TSSOP - Lead Tips Only)                                                                                                             |                        |
| *Pb-free PDIPs can be used for through hole wave solder processing only. They are not intended for use in Reflow solder processing applications. |                        |

**CAUTION:** Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

- θ<sub>JA</sub> is measured with the component mounted on a low effective thermal conductivity test board in free air. See Tech Brief TB379 for details.

**Electrical Specifications** Test Conditions: V<sub>CC</sub> = 3V to 5.5V, C1 - C4 = 0.1μF; Unless Otherwise Specified.  
Typicals are at TA = 25°C

| PARAMETER                                                                           | TEST CONDITIONS                                                                                                                |                         | TEMP<br>(°C) | MIN                  | TYP                  | MAX  | UNITS |
|-------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------|-------------------------|--------------|----------------------|----------------------|------|-------|
| DC CHARACTERISTICS                                                                  |                                                                                                                                |                         |              |                      |                      |      |       |
| Supply Current, Automatic Powerdown                                                 | All R <sub>IN</sub> Open, FORCEON = GND, $\overline{\text{FORCEOFF}} = \text{V}_{\text{CC}}$ (ICL3221, ICL3223, ICL3243 Only)  |                         | 25           | -                    | 1.0                  | 10   | μA    |
| Supply Current, Powerdown                                                           | $\overline{\text{FORCEOFF}} = \overline{\text{SHDN}} = \text{GND}$ (Except ICL3232)                                            |                         | 25           | -                    | 1.0                  | 10   | μA    |
| Supply Current, Automatic Powerdown Disabled                                        | All Outputs Unloaded, $\overline{\text{FORCEON}} = \overline{\text{FORCEOFF}} = \overline{\text{SHDN}} = \text{V}_{\text{CC}}$ | VCC = 3.15V, ICL3221-32 | 25           | -                    | 0.3                  | 1.0  | mA    |
|                                                                                     |                                                                                                                                | VCC = 3.0V, ICL3241-43  | 25           | -                    | 0.3                  | 1.0  | mA    |
| LOGIC AND TRANSMITTER INPUTS AND RECEIVER OUTPUTS                                   |                                                                                                                                |                         |              |                      |                      |      |       |
| Input Logic Threshold Low                                                           | T <sub>IN</sub> , FORCEON, $\overline{\text{FORCEOFF}}$ , $\overline{\text{EN}}$ , $\overline{\text{SHDN}}$                    |                         | Full         | -                    | -                    | 0.8  | V     |
| Input Logic Threshold High                                                          | T <sub>IN</sub> , FORCEON, $\overline{\text{FORCEOFF}}$ , $\overline{\text{EN}}$ , $\overline{\text{SHDN}}$                    | VCC = 3.3V              | Full         | 2.0                  | -                    | -    | V     |
|                                                                                     |                                                                                                                                | VCC = 5.0V              | Full         | 2.4                  | -                    | -    | V     |
| Input Leakage Current                                                               | T <sub>IN</sub> , FORCEON, $\overline{\text{FORCEOFF}}$ , $\overline{\text{EN}}$ , $\overline{\text{SHDN}}$                    |                         | Full         | -                    | ±0.01                | ±1.0 | μA    |
| Output Leakage Current (Except ICL3232)                                             | $\overline{\text{FORCEOFF}} = \text{GND}$ or $\overline{\text{EN}} = \text{V}_{\text{CC}}$                                     |                         | Full         | -                    | ±0.05                | ±10  | μA    |
| Output Voltage Low                                                                  | I <sub>OUT</sub> = 1.6mA                                                                                                       |                         | Full         | -                    | -                    | 0.4  | V     |
| Output Voltage High                                                                 | I <sub>OUT</sub> = -1.0mA                                                                                                      |                         | Full         | V <sub>CC</sub> -0.6 | V <sub>CC</sub> -0.1 | -    | V     |
| AUTOMATIC POWERDOWN (ICL3221, ICL3223, ICL3243 Only, FORCEON = GND, FORCEOFF = VCC) |                                                                                                                                |                         |              |                      |                      |      |       |
| Receiver Input Thresholds to Enable Transmitters                                    | ICL32XX Powers Up (See Figure 6)                                                                                               |                         | Full         | -2.7                 | -                    | 2.7  | V     |
| Receiver Input Thresholds to Disable Transmitters                                   | ICL32XX Powers Down (See Figure 6)                                                                                             |                         | Full         | -0.3                 | -                    | 0.3  | V     |
| $\overline{\text{INVALID}}$ Output Voltage Low                                      | I <sub>OUT</sub> = 1.6mA                                                                                                       |                         | Full         | -                    | -                    | 0.4  | V     |
| $\overline{\text{INVALID}}$ Output Voltage High                                     | I <sub>OUT</sub> = -1.0mA                                                                                                      |                         | Full         | V <sub>CC</sub> -0.6 | -                    | -    | V     |

# ICL3221, ICL3222, ICL3223, ICL3232, ICL3241, ICL3243

**Electrical Specifications** Test Conditions: VCC = 3V to 5.5V, C1 - C4 = 0.1μF; Unless Otherwise Specified.  
Typicals are at TA = 25°C (Continued)

| PARAMETER                                                                          | TEST CONDITIONS                                                                                                                                                                          |                                  | TEMP (°C) | MIN  | TYP  | MAX  | UNITS |
|------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------|-----------|------|------|------|-------|
| Receiver Threshold to Transmitters Enabled Delay (t <sub>WU</sub> )                |                                                                                                                                                                                          |                                  | 25        | -    | 100  | -    | μs    |
| Receiver Positive or Negative Threshold to INVALID High Delay (t <sub>INVH</sub> ) |                                                                                                                                                                                          |                                  | 25        | -    | 1    | -    | μs    |
| Receiver Positive or Negative Threshold to INVALID Low Delay (t <sub>INVL</sub> )  |                                                                                                                                                                                          |                                  | 25        | -    | 30   | -    | μs    |
| RECEIVER INPUTS                                                                    |                                                                                                                                                                                          |                                  |           |      |      |      |       |
| Input Voltage Range                                                                |                                                                                                                                                                                          |                                  | Full      | -25  | -    | 25   | V     |
| Input Threshold Low                                                                | V <sub>CC</sub> = 3.3V                                                                                                                                                                   |                                  | 25        | 0.6  | 1.2  | -    | V     |
|                                                                                    | V <sub>CC</sub> = 5.0V                                                                                                                                                                   |                                  | 25        | 0.8  | 1.5  | -    | V     |
| Input Threshold High                                                               | V <sub>CC</sub> = 3.3V                                                                                                                                                                   |                                  | 25        | -    | 1.5  | 2.4  | V     |
|                                                                                    | V <sub>CC</sub> = 5.0V                                                                                                                                                                   |                                  | 25        | -    | 1.8  | 2.4  | V     |
| Input Hysteresis                                                                   |                                                                                                                                                                                          |                                  | 25        | -    | 0.3  | -    | V     |
| Input Resistance                                                                   |                                                                                                                                                                                          |                                  | 25        | 3    | 5    | 7    | kΩ    |
| TRANSMITTER OUTPUTS                                                                |                                                                                                                                                                                          |                                  |           |      |      |      |       |
| Output Voltage Swing                                                               | All Transmitter Outputs Loaded with 3kΩ to Ground                                                                                                                                        |                                  | Full      | ±5.0 | ±5.4 | -    | V     |
| Output Resistance                                                                  | V <sub>CC</sub> = V+ = V- = 0V, Transmitter Output = ±2V                                                                                                                                 |                                  | Full      | 300  | 10M  | -    | Ω     |
| Output Short-Circuit Current                                                       |                                                                                                                                                                                          |                                  | Full      | -    | ±35  | ±60  | mA    |
| Output Leakage Current                                                             | V <sub>OUT</sub> = ±12V, V <sub>CC</sub> = 0V or 3V to 5.5V<br>Automatic Powerdown or FORCEOFF = SHDN = GND                                                                              |                                  | Full      | -    | -    | ±25  | μA    |
| MOUSE DRIVEABILITY (ICL324X Only)                                                  |                                                                                                                                                                                          |                                  |           |      |      |      |       |
| Transmitter Output Voltage (See Figure 9)                                          | T1 <sub>IN</sub> = T2 <sub>IN</sub> = GND, T3 <sub>IN</sub> = V <sub>CC</sub> , T3 <sub>OUT</sub> Loaded with 3kΩ to GND, T1 <sub>OUT</sub> and T2 <sub>OUT</sub> Loaded with 2.5mA Each |                                  | Full      | ±5   | -    | -    | V     |
| TIMING CHARACTERISTICS                                                             |                                                                                                                                                                                          |                                  |           |      |      |      |       |
| Maximum Data Rate                                                                  | R <sub>L</sub> = 3kΩ, C <sub>L</sub> = 1000pF, One Transmitter Switching                                                                                                                 |                                  | Full      | 250  | 500  | -    | kbps  |
| Receiver Propagation Delay                                                         | Receiver Input to Receiver Output, C <sub>L</sub> = 150pF                                                                                                                                | t <sub>PHL</sub>                 | 25        | -    | 0.3  | -    | μs    |
|                                                                                    |                                                                                                                                                                                          | t <sub>PLH</sub>                 | 25        | -    | 0.3  | -    | μs    |
| Receiver Output Enable Time                                                        | Normal Operation (Except ICL3232)                                                                                                                                                        |                                  | 25        | -    | 200  | -    | ns    |
| Receiver Output Disable Time                                                       | Normal Operation (Except ICL3232)                                                                                                                                                        |                                  | 25        | -    | 200  | -    | ns    |
| Transmitter Skew                                                                   | t <sub>PHL</sub> - t <sub>PLH</sub>                                                                                                                                                      |                                  | Full      | -    | 200  | 1000 | ns    |
| Receiver Skew                                                                      | t <sub>PHL</sub> - t <sub>PLH</sub>                                                                                                                                                      |                                  | Full      | -    | 100  | 500  | ns    |
| Transition Region Slew Rate                                                        | V <sub>CC</sub> = 3.3V, R <sub>L</sub> = 3kΩ to 7kΩ, Measured From 3V to -3V or -3V to 3V                                                                                                | C <sub>L</sub> = 200pF to 2500pF | 25        | 4    | 8.0  | 30   | V/μs  |
|                                                                                    |                                                                                                                                                                                          | C <sub>L</sub> = 200pF to 1000pF | 25        | 6    | -    | 30   | V/μs  |
| ESD PERFORMANCE                                                                    |                                                                                                                                                                                          |                                  |           |      |      |      |       |
| RS-232 Pins (T <sub>OUT</sub> , R <sub>IN</sub> )                                  | Human Body Model                                                                                                                                                                         | ICL3221 - ICL3243                | 25        | -    | ±15  | -    | kV    |
|                                                                                    | IEC61000-4-2 Contact Discharge                                                                                                                                                           | ICL3221 - ICL3243                | 25        | -    | ±8   | -    | kV    |
|                                                                                    | IEC61000-4-2 Air Gap Discharge                                                                                                                                                           | ICL3221 - ICL3232                | 25        | -    | ±8   | -    | kV    |
|                                                                                    |                                                                                                                                                                                          | ICL3241 - ICL3243                | 25        | -    | ±6   | -    | kV    |
| All Other Pins                                                                     | Human Body Model                                                                                                                                                                         | ICL3221 - ICL3243                | 25        | -    | ±2   | -    | kV    |

## Detailed Description

ICL32XX interface ICs operate from a single +3V to +5.5V supply, guarantee a 250kbps minimum data rate, require only four small external 0.1μF capacitors, feature low power consumption, and meet all EIA RS-232C and V.28 specifications. The circuit is divided into three sections: charge pump, transmitters and receivers.

### Charge-Pump

Intersil's new ICL32XX family utilizes regulated on-chip dual charge pumps as voltage doublers, and voltage inverters to generate ±5.5V transmitter supplies from a  $V_{CC}$  supply as low as 3.0V. This allows these devices to maintain RS-232 compliant output levels over the ±10% tolerance range of 3.3V powered systems. The efficient on-chip power supplies require only four small, external 0.1μF capacitors for the voltage doubler and inverter functions at  $V_{CC} = 3.3V$ . See the *Capacitor Selection* section, and Table 3 for capacitor recommendations for other operating conditions. The charge pumps operate discontinuously (i.e., they turn off as soon as the V+ and V- supplies are pumped up to the nominal values), resulting in significant power savings.

### Transmitters

The transmitters are proprietary, low dropout, inverting drivers that translate TTL/CMOS inputs to EIA/TIA-232 output levels. Coupled with the on-chip ±5.5V supplies, these transmitters deliver true RS-232 levels over a wide range of single supply system voltages.

Except for the ICL3232, all transmitter outputs disable and assume a high impedance state when the device enters the powerdown mode (See Table 2). These outputs may be driven to ±12V when disabled.

All devices guarantee a 250kbps data rate for full load conditions (3kΩ and 1000pF),  $V_{CC} \geq 3.0V$ , with one transmitter operating at full speed. Under more typical conditions of  $V_{CC} \geq 3.3V$ ,  $R_L = 3k\Omega$ , and  $C_L = 250pF$ , one transmitter easily operates at 900kbps.

Transmitter inputs float if left unconnected, and may cause  $I_{CC}$  increases. Connect unused inputs to GND for the best performance.

### Receivers

All the ICL32XX devices contain standard inverting receivers that three-state (except for the ICL3232) via the EN or FORCEOFF control lines. Additionally, the two ICL324X products include noninverting (monitor) receivers (denoted by the  $R_{OUTB}$  label) that are always active, regardless of the state of any control lines. All the receivers convert RS-232 signals to CMOS output levels and accept inputs up to ±25V while presenting the required 3kΩ to 7kΩ input impedance (See Figure 1) even if the power is off ( $V_{CC} = 0V$ ). The receivers' Schmitt trigger input stage uses hysteresis to increase noise immunity and decrease errors due to slow input signal transitions.

The ICL3221/22/23/41 inverting receivers disable only when  $\overline{EN}$  is driven high. ICL3243 receivers disable during forced (manual) powerdown, but not during automatic powerdown (See Table 2).

ICL324X monitor receivers remain active even during manual powerdown and forced receiver disable, making them extremely useful for Ring Indicator monitoring. Standard receivers driving powered down peripherals must be disabled to prevent current flow through the peripheral's protection diodes (See Figures 2 and 3). This renders them useless for wake up functions, but the corresponding monitor receiver can be dedicated to this task as shown in Figure 3.

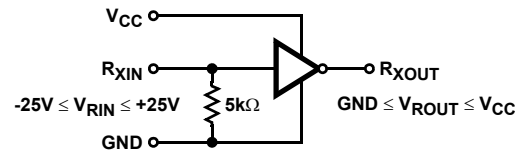


FIGURE 1. INVERTING RECEIVER CONNECTIONS

### Low Power Operation

These 3V devices require a nominal supply current of 0.3mA, even at  $V_{CC} = 5.5V$ , during normal operation (not in powerdown mode). This is considerably less than the 5mA to 11mA current required by comparable 5V RS-232 devices, allowing users to reduce system power simply by switching to this new family.

### Pin Compatible Replacements For 5V Devices

The ICL3221/22/32 are pin compatible with existing 5V RS-232 transceivers - see the *Features* section on the front page for details.

This pin compatibility coupled with the low  $I_{CC}$  and wide operating supply range, make the ICL32XX potential lower power, higher performance drop-in replacements for existing 5V applications. As long as the ±5V RS-232 output swings are acceptable, and transmitter input pull-up resistors aren't required, the ICL32XX should work in most 5V applications.

When replacing a device in an existing 5V application, it is acceptable to terminate  $C_3$  to  $V_{CC}$  as shown on the *Typical Operating Circuit*. Nevertheless, terminate  $C_3$  to GND if possible, as slightly better performance results from this configuration.

### Powerdown Functionality (Except ICL3232)

The already low current requirement drops significantly when the device enters powerdown mode. In powerdown, supply current drops to 1μA, because the on-chip charge pump turns off ( $V_+$  collapses to  $V_{CC}$ ,  $V_-$  collapses to GND), and the transmitter outputs three-state. Inverting receiver outputs may or may not disable in powerdown; refer to Table 2 for details. This micro-power mode makes these devices ideal for battery powered and portable applications.

### Software Controlled (Manual) Powerdown

Most devices in the ICL32XX family provide pins that allow the user to force the IC into the low power, standby state.

On the ICL3222 and ICL3241, the powerdown control is via a simple shutdown (SHDN) pin. Driving this pin high enables normal operation, while driving it low forces the IC into its powerdown state. Connect SHDN to V<sub>CC</sub> if the powerdown function isn't needed. Note that all the receiver outputs remain enabled during shutdown (See Table 2). For the lowest power consumption during powerdown, the receivers should also be disabled by driving the  $\overline{\text{EN}}$  input high (See next section, and Figures 2 and 3).

The ICL3221, ICL3223, and ICL3243 utilize a two pin approach where the FORCEON and  $\overline{\text{FORCEOFF}}$  inputs determine the IC's mode. For always enabled operation, FORCEON and  $\overline{\text{FORCEOFF}}$  are both strapped high. To switch between active and powerdown modes, under logic or software control, only the  $\overline{\text{FORCEOFF}}$  input need be driven. The FORCEON state isn't critical, as  $\overline{\text{FORCEOFF}}$  dominates over FORCEON. Nevertheless, if strictly manual control over powerdown is desired, the user must strap FORCEON high to disable the automatic powerdown circuitry. ICL3243 inverting (standard) receiver outputs also disable when the device is in manual powerdown, thereby eliminating the possible current path through a shutdown peripheral's input protection diode (See Figures 2 and 3).

**TABLE 2. POWERDOWN AND ENABLE LOGIC TRUTH TABLE**

| RS-232<br>SIGNAL<br>PRESENT<br>AT<br>RECEIVER<br>INPUT? | $\overline{\text{FORCEOFF}}$<br>OR SHDN<br>INPUT | FORCEON<br>INPUT | $\overline{\text{EN}}$<br>INPUT | TRANSMITTER<br>OUTPUTS | RECEIVER<br>OUTPUTS | (NOTE 4)<br>ROUTB<br>OUTPUTS | $\overline{\text{INVALID}}$<br>OUTPUT | MODE OF OPERATION                             |
|---------------------------------------------------------|--------------------------------------------------|------------------|---------------------------------|------------------------|---------------------|------------------------------|---------------------------------------|-----------------------------------------------|
| <b>ICL3222, ICL3241</b>                                 |                                                  |                  |                                 |                        |                     |                              |                                       |                                               |
| N.A.                                                    | L                                                | N.A.             | L                               | High-Z                 | Active              | Active                       | N.A.                                  | Manual Powerdown                              |
| N.A.                                                    | L                                                | N.A.             | H                               | High-Z                 | High-Z              | Active                       | N.A.                                  | Manual Powerdown w/Rcvr. Disabled             |
| N.A.                                                    | H                                                | N.A.             | L                               | Active                 | Active              | Active                       | N.A.                                  | Normal Operation                              |
| N.A.                                                    | H                                                | N.A.             | H                               | Active                 | High-Z              | Active                       | N.A.                                  | Normal Operation w/Rcvr. Disabled             |
| <b>ICL3221, ICL3223</b>                                 |                                                  |                  |                                 |                        |                     |                              |                                       |                                               |
| No                                                      | H                                                | H                | L                               | Active                 | Active              | N.A.                         | L                                     | Normal Operation<br>(Auto Powerdown Disabled) |
| No                                                      | H                                                | H                | H                               | Active                 | High-Z              | N.A.                         | L                                     |                                               |
| Yes                                                     | H                                                | L                | L                               | Active                 | Active              | N.A.                         | H                                     | Normal Operation<br>(Auto Powerdown Enabled)  |
| Yes                                                     | H                                                | L                | H                               | Active                 | High-Z              | N.A.                         | H                                     |                                               |
| No                                                      | H                                                | L                | L                               | High-Z                 | Active              | N.A.                         | L                                     | Powerdown Due to Auto Powerdown<br>Logic      |
| No                                                      | H                                                | L                | H                               | High-Z                 | High-Z              | N.A.                         | L                                     |                                               |
| Yes                                                     | L                                                | X                | L                               | High-Z                 | Active              | N.A.                         | H                                     | Manual Powerdown                              |
| Yes                                                     | L                                                | X                | H                               | High-Z                 | High-Z              | N.A.                         | H                                     | Manual Powerdown w/Rcvr. Disabled             |
| No                                                      | L                                                | X                | L                               | High-Z                 | Active              | N.A.                         | L                                     | Manual Powerdown                              |
| No                                                      | L                                                | X                | H                               | High-Z                 | High-Z              | N.A.                         | L                                     | Manual Powerdown w/Rcvr. Disabled             |
| <b>ICL3243</b>                                          |                                                  |                  |                                 |                        |                     |                              |                                       |                                               |
| No                                                      | H                                                | H                | N.A.                            | Active                 | Active              | Active                       | L                                     | Normal Operation<br>(Auto Powerdown Disabled) |
| Yes                                                     | H                                                | L                | N.A.                            | Active                 | Active              | Active                       | H                                     | Normal Operation<br>(Auto Powerdown Enabled)  |
| No                                                      | H                                                | L                | N.A.                            | High-Z                 | Active              | Active                       | L                                     | Powerdown Due to Auto Powerdown<br>Logic      |
| Yes                                                     | L                                                | X                | N.A.                            | High-Z                 | High-Z              | Active                       | H                                     | Manual Powerdown                              |
| No                                                      | L                                                | X                | N.A.                            | High-Z                 | High-Z              | Active                       | L                                     | Manual Powerdown                              |

NOTE:

4. Applies only to the ICL3241 and ICL3243.

The  $\overline{\text{INVALID}}$  output always indicates whether or not a valid RS-232 signal is present at any of the receiver inputs (See Table 2), giving the user an easy way to determine when the interface block should power down. In the case of a disconnected interface cable where all the receiver inputs are floating (but pulled to GND by the internal receiver pull down resistors), the  $\overline{\text{INVALID}}$  logic detects the invalid levels and drives the output low. The power management logic then uses this indicator to power down the interface block. Reconnecting the cable restores valid levels at the receiver inputs,  $\overline{\text{INVALID}}$  switches high, and the power management logic wakes up the interface block.  $\overline{\text{INVALID}}$  can also be used to indicate the DTR or RING INDICATOR signal, as long as the other receiver inputs are floating, or driven to GND (as in the case of a powered down driver). Connecting  $\overline{\text{FORCEOFF}}$  and  $\overline{\text{FORCEON}}$  together disables the automatic powerdown feature, enabling them to function as a manual SHUTDOWN input (See Figure 4).

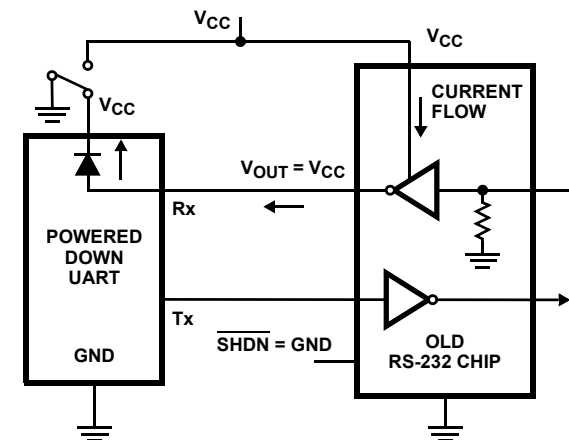


FIGURE 2. POWER DRAIN THROUGH POWERED DOWN PERIPHERAL

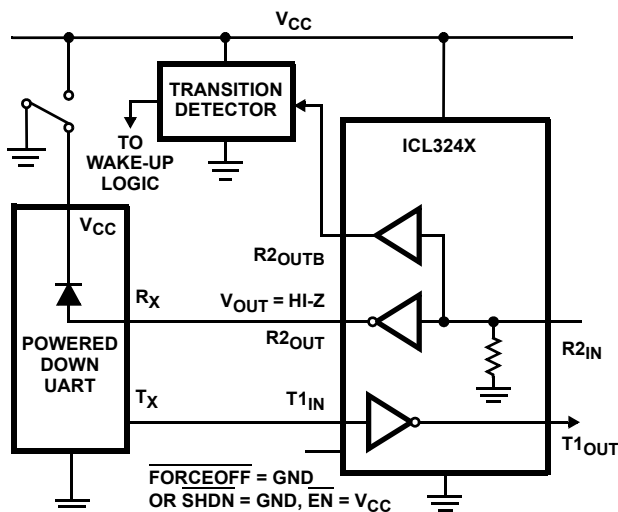


FIGURE 3. DISABLED RECEIVERS PREVENT POWER DRAIN

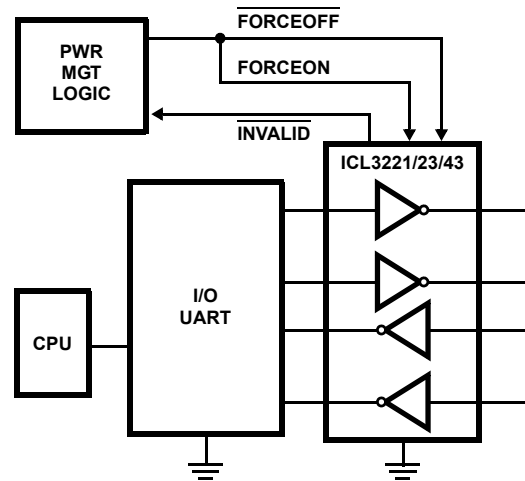


FIGURE 4. CONNECTIONS FOR MANUAL POWERDOWN WHEN NO VALID RECEIVER SIGNALS ARE PRESENT

With any of the above control schemes, the time required to exit powerdown, and resume transmission is only 100 $\mu$ s. A mouse, or other application, may need more time to wake up from shutdown. If automatic powerdown is being utilized, the RS-232 device will reenter powerdown if valid receiver levels aren't reestablished within 30 $\mu$ s of the ICL32XX powering up. Figure 5 illustrates a circuit that keeps the ICL32XX from initiating automatic powerdown for 100ms after powering up. This gives the slow-to-wake peripheral circuit time to reestablish valid RS-232 output levels.

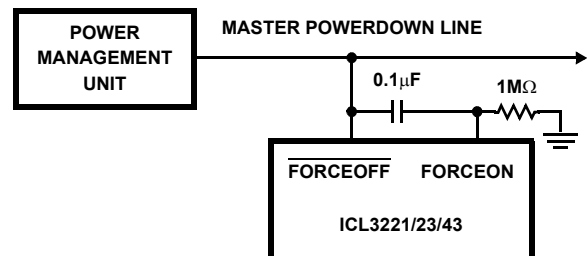


FIGURE 5. CIRCUIT TO PREVENT AUTO POWERDOWN FOR 100ms AFTER FORCED POWERUP

### Automatic Powerdown (ICL3221/23/43 Only)

Even greater power savings is available by using the devices which feature an *automatic* powerdown function. When no valid RS-232 voltages (See Figure 6) are sensed on any receiver input for 30 $\mu$ s, the charge pump and transmitters powerdown, thereby reducing supply current to 1 $\mu$ A. Invalid receiver levels occur whenever the driving peripheral's outputs are shut off (powered down) or when the RS-232 interface cable is disconnected. The ICL32XX powers back up whenever it detects a valid RS-232 voltage level on any receiver input. This automatic powerdown feature provides additional system power savings without changes to the existing operating system.

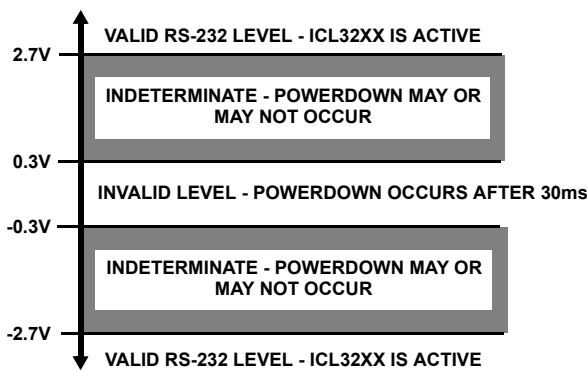


FIGURE 6. DEFINITION OF VALID RS-232 RECEIVER LEVELS

Automatic powerdown operates when the FORCEON input is low, and the FORCEOFF input is high. Tying FORCEON high disables automatic powerdown, but manual powerdown is always available via the overriding FORCEOFF input. Table 2 summarizes the automatic powerdown functionality.

Devices with the automatic powerdown feature include an  $\overline{\text{INVALID}}$  output signal, which switches low to indicate that invalid levels have persisted on all of the receiver inputs for more than 30 $\mu\text{s}$  (See Figure 7).  $\overline{\text{INVALID}}$  switches high 1 $\mu\text{s}$  after detecting a valid RS-232 level on a receiver input.  $\overline{\text{INVALID}}$  operates in all modes (forced or automatic powerdown, or forced on), so it is also useful for systems employing manual powerdown circuitry. When automatic powerdown is utilized,  $\overline{\text{INVALID}} = 0$  indicates that the ICL32XX is in powerdown mode.

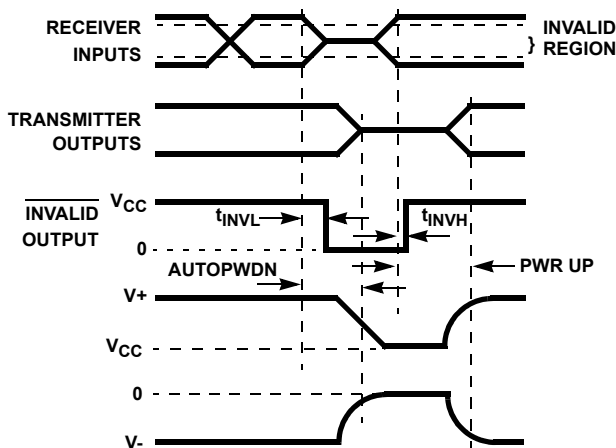


FIGURE 7. AUTOMATIC POWERDOWN AND  $\overline{\text{INVALID}}$  TIMING DIAGRAMS

The time to recover from automatic powerdown mode is typically 100 $\mu\text{s}$ .

#### Receiver ENABLE Control (ICL3221/22/23/41 Only)

Several devices also feature an  $\overline{\text{EN}}$  input to control the receiver outputs. Driving  $\overline{\text{EN}}$  high disables all the inverting

(standard) receiver outputs placing them in a high impedance state. This is useful to eliminate supply current, due to a receiver output forward biasing the protection diode, when driving the input of a powered down ( $V_{\text{CC}} = \text{GND}$ ) peripheral (See Figure 2). The enable input has no effect on transmitter nor monitor ( $R_{\text{OUTB}}$ ) outputs.

#### Capacitor Selection

The charge pumps require 0.1 $\mu\text{F}$  capacitors for 3.3V operation. For other supply voltages refer to Table 3 for capacitor values. Do not use values smaller than those listed in Table 3. Increasing the capacitor values (by a factor of 2) reduces ripple on the transmitter outputs and slightly reduces power consumption.  $C_2$ ,  $C_3$ , and  $C_4$  can be increased without increasing  $C_1$ 's value, however, do not increase  $C_1$  without also increasing  $C_2$ ,  $C_3$ , and  $C_4$  to maintain the proper ratios ( $C_1$  to the other capacitors).

When using minimum required capacitor values, make sure that capacitor values do not degrade excessively with temperature. If in doubt, use capacitors with a larger nominal value. The capacitor's equivalent series resistance (ESR) usually rises at low temperatures and it influences the amount of ripple on  $V+$  and  $V-$ .

TABLE 3. REQUIRED CAPACITOR VALUES

| $V_{\text{CC}}$<br>(V) | $C_1$<br>( $\mu\text{F}$ ) | $C_2, C_3, C_4$<br>( $\mu\text{F}$ ) |
|------------------------|----------------------------|--------------------------------------|
| 3.0 to 3.6             | 0.1                        | 0.1                                  |
| 4.5 to 5.5             | 0.047                      | 0.33                                 |
| 3.0 to 5.5             | 0.1                        | 0.47                                 |

#### Power Supply Decoupling

In most circumstances a 0.1 $\mu\text{F}$  bypass capacitor is adequate. In applications that are particularly sensitive to power supply noise, decouple  $V_{\text{CC}}$  to ground with a capacitor of the same value as the charge-pump capacitor  $C_1$ . Connect the bypass capacitor as close as possible to the IC.

#### Operation Down to 2.7V

ICL32XX transmitter outputs meet RS-562 levels ( $\pm 3.7\text{V}$ ), at full data rate, with  $V_{\text{CC}}$  as low as 2.7V. RS-562 levels typically ensure interoperability with RS-232 devices.

#### Transmitter Outputs when Exiting Powerdown

Figure 8 shows the response of two transmitter outputs when exiting powerdown mode. As they activate, the two transmitter outputs properly go to opposite RS-232 levels, with no glitching, ringing, nor undesirable transients. Each transmitter is loaded with 3k $\Omega$  in parallel with 2500pF. Note that the transmitters enable only when the magnitude of the supplies exceed approximately 3V.

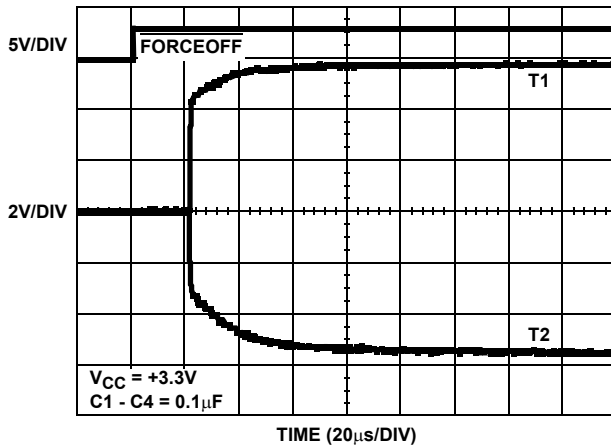


FIGURE 8. TRANSMITTER OUTPUTS WHEN EXITING POWERDOWN

### Mouse Driveability

The ICL324X have been specifically designed to power a serial mouse while operating from low voltage supplies. Figure 9 shows the transmitter output voltages under increasing load current. The on-chip switching regulator ensures the transmitters will supply at least  $\pm 5V$  during worst case conditions (15mA for paralleled V+ transmitters, 7.3mA for single V- transmitter). The Automatic Powerdown feature does not work with a mouse, so **FORCEOFF** and **FORCEON** should be connected to  $V_{CC}$ .

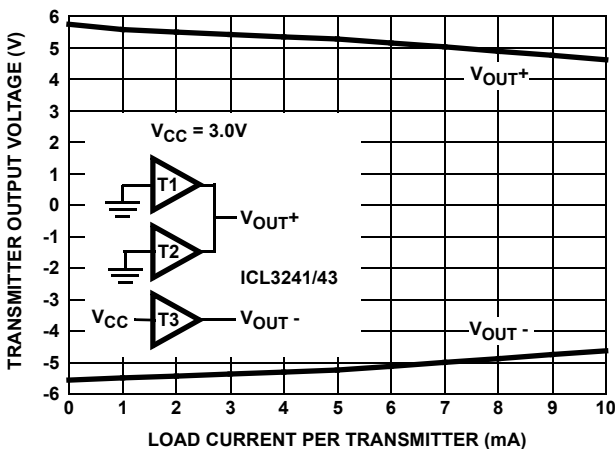


FIGURE 9. TRANSMITTER OUTPUT VOLTAGE vs LOAD CURRENT (PER TRANSMITTER, i.e., DOUBLE CURRENT AXIS FOR TOTAL  $V_{OUT+}$  CURRENT)

### High Data Rates

The ICL32XX maintain the RS-232  $\pm 5V$  minimum transmitter output voltages even at high data rates. Figure 10 details a transmitter loopback test circuit, and Figure 11 illustrates the loopback test result at 120kbps. For this test, all transmitters were simultaneously driving RS-232 loads in parallel with 1000pF, at 120kbps. Figure 12 shows the loopback results

for a single transmitter driving 1000pF and an RS-232 load at 250kbps. The static transmitters were also loaded with an RS-232 receiver.

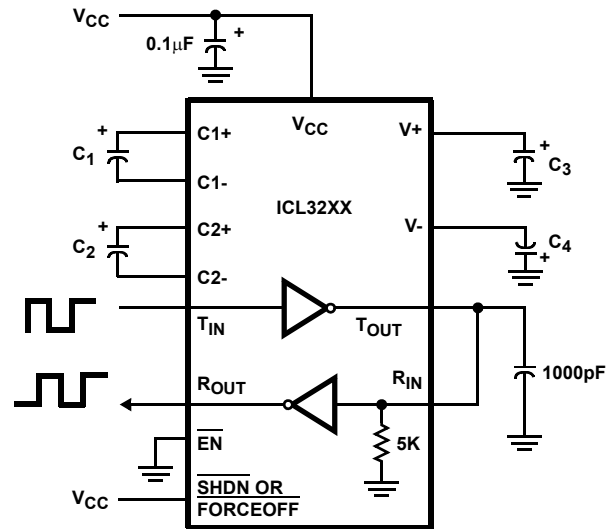


FIGURE 10. TRANSMITTER LOOPBACK TEST CIRCUIT

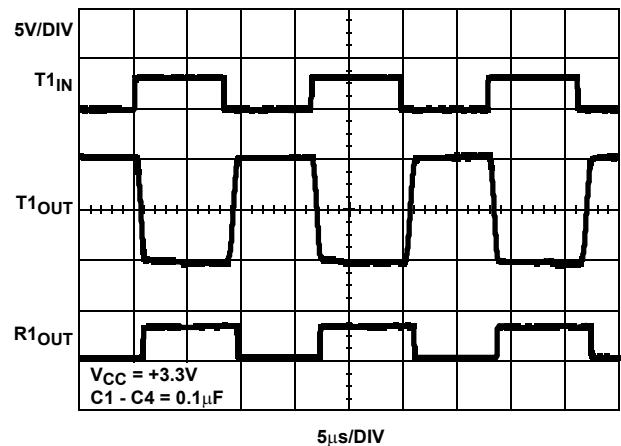


FIGURE 11. LOOPBACK TEST AT 120kbps

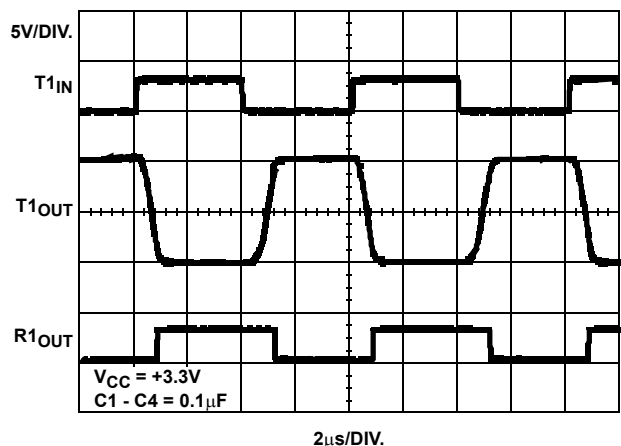


FIGURE 12. LOOPBACK TEST AT 250kbps

## Interconnection with 3V and 5V Logic

The ICL32XX directly interface with 5V CMOS and TTL logic families. Nevertheless, with the ICL32XX at 3.3V, and the logic supply at 5V, AC, HC, and CD4000 outputs can drive ICL32XX inputs, but ICL32XX outputs do not reach the minimum  $V_{IH}$  for these logic families. See Table 4 for more information.

TABLE 4. LOGIC FAMILY COMPATIBILITY WITH VARIOUS SUPPLY VOLTAGES

| SYSTEM POWER-SUPPLY VOLTAGE (V) | V <sub>CC</sub> SUPPLY VOLTAGE (V) | COMPATIBILITY                                                                                                         |
|---------------------------------|------------------------------------|-----------------------------------------------------------------------------------------------------------------------|
| 3.3                             | 3.3                                | Compatible with all CMOS families.                                                                                    |
| 5                               | 5                                  | Compatible with all TTL and CMOS logic families.                                                                      |
| 5                               | 3.3                                | Compatible with ACT and HCT CMOS, and with TTL. ICL32XX outputs are incompatible with AC, HC, and CD4000 CMOS inputs. |

## Typical Performance Curves $V_{CC} = 3.3V$ , $T_A = 25^\circ C$

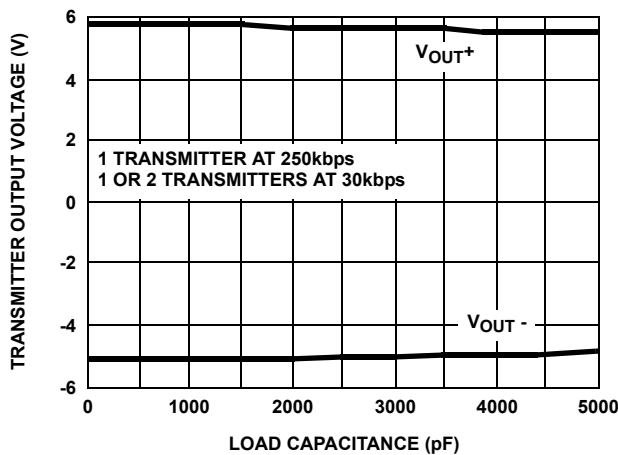


FIGURE 13. TRANSMITTER OUTPUT VOLTAGE vs LOAD CAPACITANCE

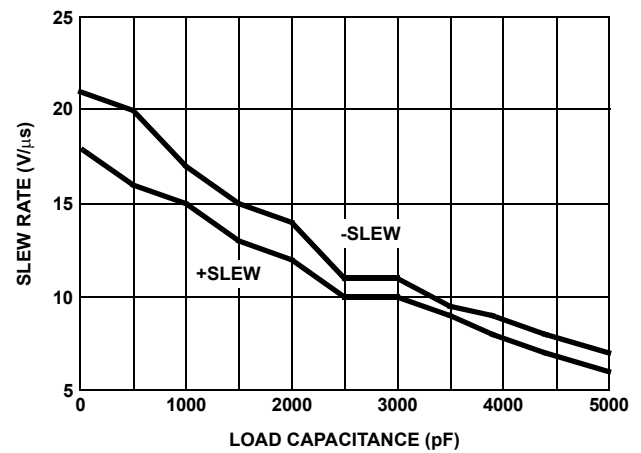


FIGURE 14. SLEW RATE vs LOAD CAPACITANCE

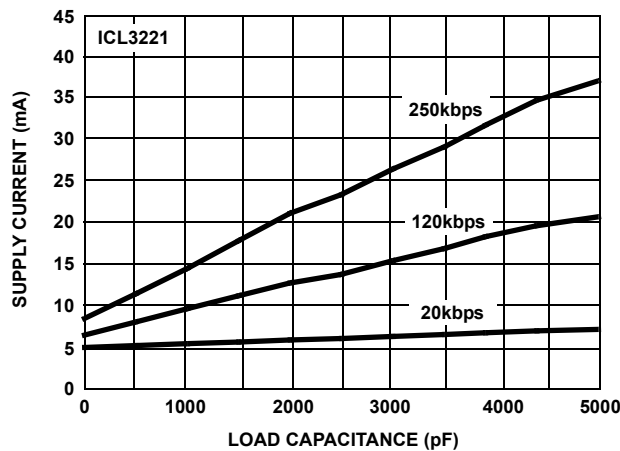


FIGURE 15. SUPPLY CURRENT vs LOAD CAPACITANCE WHEN TRANSMITTING DATA

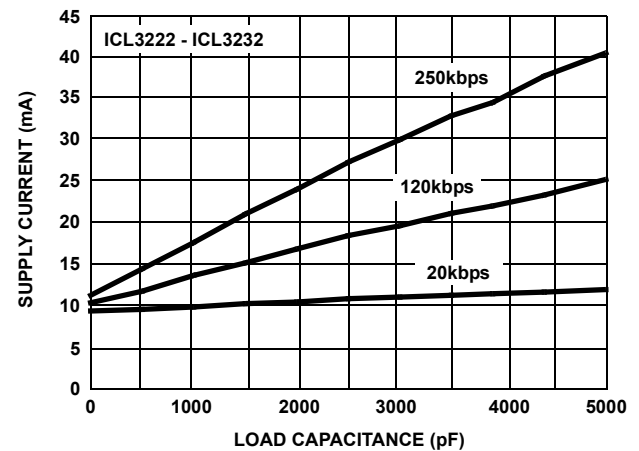


FIGURE 16. SUPPLY CURRENT vs LOAD CAPACITANCE WHEN TRANSMITTING DATA

**Typical Performance Curves**  $V_{CC} = 3.3V$ ,  $T_A = 25^\circ C$  (Continued)

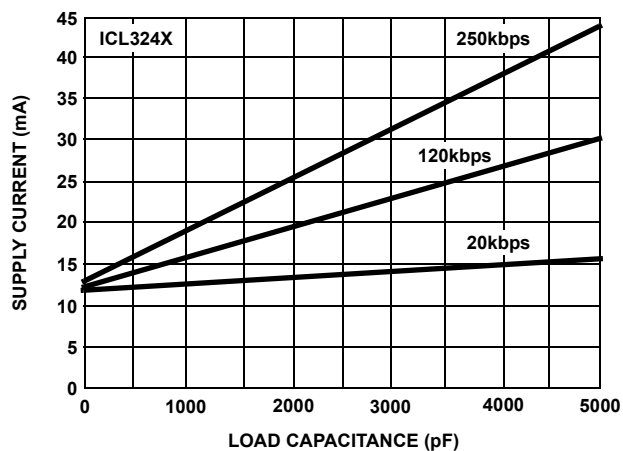


FIGURE 17. SUPPLY CURRENT vs LOAD CAPACITANCE WHEN TRANSMITTING DATA

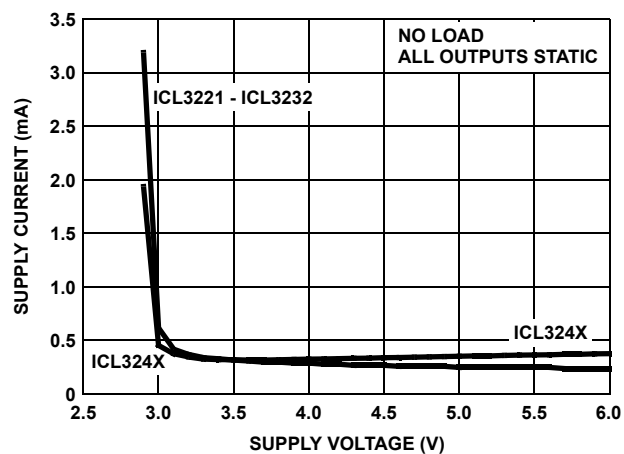


FIGURE 18. SUPPLY CURRENT vs SUPPLY VOLTAGE

**Die Characteristics**

SUBSTRATE POTENTIAL (POWERED UP):

GND

TRANSISTOR COUNT:

ICL3221: 286

ICL3222: 338

ICL3223: 357

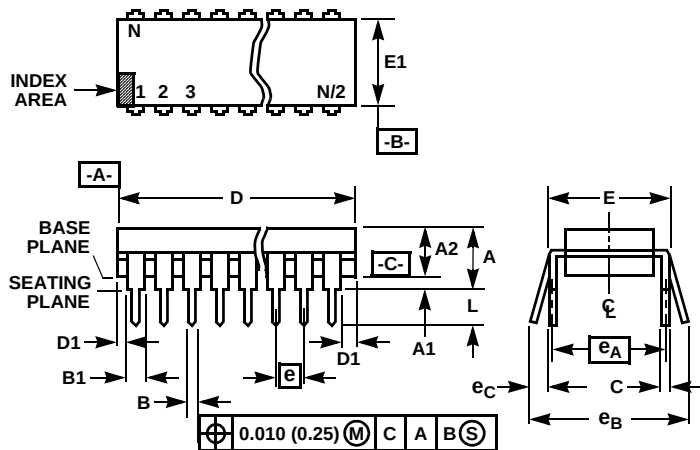
ICL3232: 296

ICL324X: 464

PROCESS:

Si Gate CMOS

## Dual-In-Line Plastic Packages (PDIP)



### NOTES:

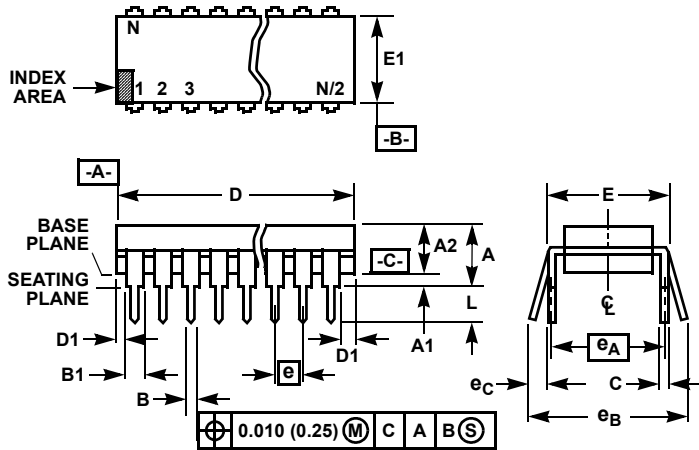
1. Controlling Dimensions: INCH. In case of conflict between English and Metric dimensions, the inch dimensions control.
2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
3. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication No. 95.
4. Dimensions A, A1 and L are measured with the package seated in JEDEC seating plane gauge GS-3.
5. D, D1, and E1 dimensions do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.010 inch (0.25mm).
6. E and  $e_A$  are measured with the leads constrained to be perpendicular to datum  $-C-$ .
7.  $e_B$  and  $e_C$  are measured at the lead tips with the leads unconstrained.  $e_C$  must be zero or greater.
8. B1 maximum dimensions do not include dambar protrusions. Dambar protrusions shall not exceed 0.010 inch (0.25mm).
9. N is the maximum number of terminal positions.
10. Corner leads (1, N, N/2 and N/2 + 1) for E8.3, E16.3, E18.3, E28.3, E42.6 will have a B1 dimension of 0.030 - 0.045 inch (0.76 - 1.14mm).

### E16.3 (JEDEC MS-001-BB ISSUE D) 16 LEAD DUAL-IN-LINE PLASTIC PACKAGE

| SYMBOL | INCHES    |       | MILLIMETERS |       | NOTES |
|--------|-----------|-------|-------------|-------|-------|
|        | MIN       | MAX   | MIN         | MAX   |       |
| A      | -         | 0.210 | -           | 5.33  | 4     |
| A1     | 0.015     | -     | 0.39        | -     | 4     |
| A2     | 0.115     | 0.195 | 2.93        | 4.95  | -     |
| B      | 0.014     | 0.022 | 0.356       | 0.558 | -     |
| B1     | 0.045     | 0.070 | 1.15        | 1.77  | 8, 10 |
| C      | 0.008     | 0.014 | 0.204       | 0.355 | -     |
| D      | 0.735     | 0.775 | 18.66       | 19.68 | 5     |
| D1     | 0.005     | -     | 0.13        | -     | 5     |
| E      | 0.300     | 0.325 | 7.62        | 8.25  | 6     |
| E1     | 0.240     | 0.280 | 6.10        | 7.11  | 5     |
| e      | 0.100 BSC |       | 2.54 BSC    |       | -     |
| $e_A$  | 0.300 BSC |       | 7.62 BSC    |       | 6     |
| $e_B$  | -         | 0.430 | -           | 10.92 | 7     |
| L      | 0.115     | 0.150 | 2.93        | 3.81  | 4     |
| N      | 16        |       | 16          |       | 9     |

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## Dual-In-Line Plastic Packages (PDIP)



### NOTES:

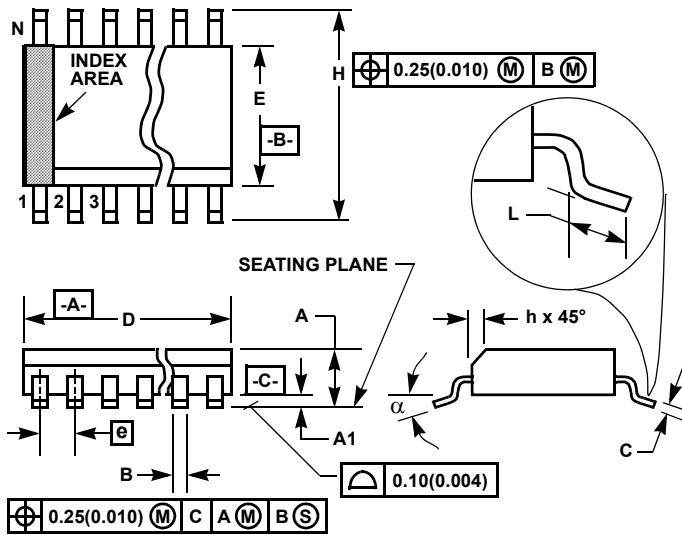
1. Controlling Dimensions: INCH. In case of conflict between English and Metric dimensions, the inch dimensions control.
2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
3. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication No. 95.
4. Dimensions A, A1 and L are measured with the package seated in JEDEC seating plane gauge GS-3.
5. D, D1, and E1 dimensions do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.010 inch (0.25mm).
6. E and  $e_A$  are measured with the leads constrained to be perpendicular to datum  $-C-$ .
7.  $e_B$  and  $e_C$  are measured at the lead tips with the leads unconstrained.  $e_C$  must be zero or greater.
8. B1 maximum dimensions do not include dambar protrusions. Dambar protrusions shall not exceed 0.010 inch (0.25mm).
9. N is the maximum number of terminal positions.
10. Corner leads (1, N, N/2 and N/2 + 1) for E8.3, E16.3, E18.3, E28.3 may have a B1 dimension of 0.030 - 0.045 inch (0.76 - 1.14mm).

### E18.3 (JEDEC MS-001-BC ISSUE D) 18 LEAD DUAL-IN-LINE PLASTIC PACKAGE

| SYMBOL | INCHES    |       | MILLIMETERS |       | NOTES |
|--------|-----------|-------|-------------|-------|-------|
|        | MIN       | MAX   | MIN         | MAX   |       |
| A      | -         | 0.210 | -           | 5.33  | 4     |
| A1     | 0.015     | -     | 0.39        | -     | 4     |
| A2     | 0.115     | 0.195 | 2.93        | 4.95  | -     |
| B      | 0.014     | 0.022 | 0.356       | 0.558 | -     |
| B1     | 0.045     | 0.070 | 1.15        | 1.77  | 8, 10 |
| C      | 0.008     | 0.014 | 0.204       | 0.355 | -     |
| D      | 0.845     | 0.880 | 21.47       | 22.35 | 5     |
| D1     | 0.005     | -     | 0.13        | -     | 5     |
| E      | 0.300     | 0.325 | 7.62        | 8.25  | 6     |
| E1     | 0.240     | 0.280 | 6.10        | 7.11  | 5     |
| e      | 0.100 BSC |       | 2.54 BSC    |       | -     |
| $e_A$  | 0.300 BSC |       | 7.62 BSC    |       | 6     |
| $e_B$  | -         | 0.430 | -           | 10.92 | 7     |
| L      | 0.115     | 0.150 | 2.93        | 3.81  | 4     |
| N      | 18        |       | 18          |       | 9     |

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## Small Outline Plastic Packages (SOIC)



### NOTES:

1. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication Number 95.
2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
3. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
4. Dimension "E" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25mm (0.010 inch) per side.
5. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
6. "L" is the length of terminal for soldering to a substrate.
7. "N" is the number of terminal positions.
8. Terminal numbers are shown for reference only.
9. The lead width "B", as measured 0.36mm (0.014 inch) or greater above the seating plane, shall not exceed a maximum value of 0.61mm (0.024 inch).
10. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.

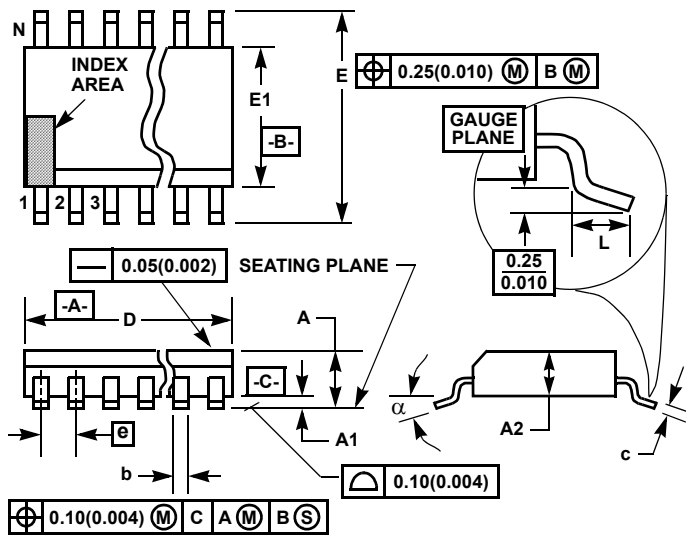
### M16.15 (JEDEC MS-012-AC ISSUE C)

#### 16 LEAD NARROW BODY SMALL OUTLINE PLASTIC PACKAGE

| SYMBOL   | INCHES    |        | MILLIMETERS |       | NOTES |
|----------|-----------|--------|-------------|-------|-------|
|          | MIN       | MAX    | MIN         | MAX   |       |
| A        | 0.0532    | 0.0688 | 1.35        | 1.75  | -     |
| A1       | 0.0040    | 0.0098 | 0.10        | 0.25  | -     |
| B        | 0.013     | 0.020  | 0.33        | 0.51  | 9     |
| C        | 0.0075    | 0.0098 | 0.19        | 0.25  | -     |
| D        | 0.3859    | 0.3937 | 9.80        | 10.00 | 3     |
| E        | 0.1497    | 0.1574 | 3.80        | 4.00  | 4     |
| e        | 0.050 BSC |        | 1.27 BSC    |       | -     |
| H        | 0.2284    | 0.2440 | 5.80        | 6.20  | -     |
| h        | 0.0099    | 0.0196 | 0.25        | 0.50  | 5     |
| L        | 0.016     | 0.050  | 0.40        | 1.27  | 6     |
| N        | 16        |        | 16          |       | 7     |
| $\alpha$ | 0°        | 8°     | 0°          | 8°    | -     |

Rev. 1 6/05

# Thin Shrink Small Outline Plastic Packages (TSSOP)



## NOTES:

1. These package dimensions are within allowable dimensions of JEDEC MO-153-AB, Issue E.
2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
3. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
4. Dimension "E1" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.15mm (0.006 inch) per side.
5. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
6. "L" is the length of terminal for soldering to a substrate.
7. "N" is the number of terminal positions.
8. Terminal numbers are shown for reference only.
9. Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.08mm (0.003 inch) total in excess of "b" dimension at maximum material condition. Minimum space between protrusion and adjacent lead is 0.07mm (0.0027 inch).
10. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact. (Angles in degrees)

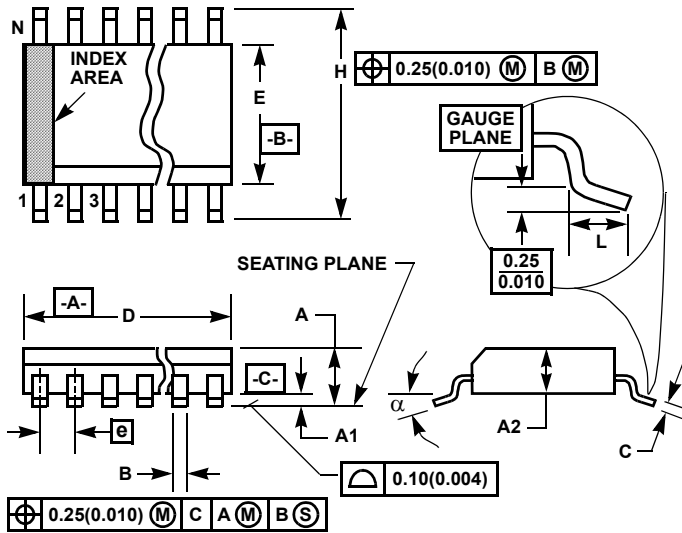
## M16.173

### 16 LEAD THIN SHRINK SMALL OUTLINE PLASTIC PACKAGE

| SYMBOL | INCHES    |       | MILLIMETERS |      | NOTES |
|--------|-----------|-------|-------------|------|-------|
|        | MIN       | MAX   | MIN         | MAX  |       |
| A      | -         | 0.043 | -           | 1.10 | -     |
| A1     | 0.002     | 0.006 | 0.05        | 0.15 | -     |
| A2     | 0.033     | 0.037 | 0.85        | 0.95 | -     |
| b      | 0.0075    | 0.012 | 0.19        | 0.30 | 9     |
| c      | 0.0035    | 0.008 | 0.09        | 0.20 | -     |
| D      | 0.193     | 0.201 | 4.90        | 5.10 | 3     |
| E1     | 0.169     | 0.177 | 4.30        | 4.50 | 4     |
| e      | 0.026 BSC |       | 0.65 BSC    |      | -     |
| E      | 0.246     | 0.256 | 6.25        | 6.50 | -     |
| L      | 0.020     | 0.028 | 0.50        | 0.70 | 6     |
| N      | 16        |       | 16          |      | 7     |
| α      | 0°        | 8°    | 0°          | 8°   | -     |

Rev. 1 2/02

## Small Outline Plastic Packages (SSOP)



### NOTES:

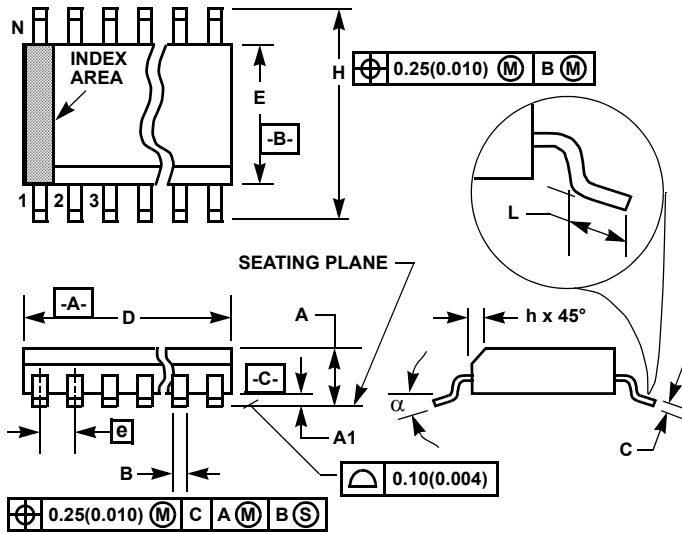
1. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication Number 95.
2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
3. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.20mm (0.0078 inch) per side.
4. Dimension "E" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.20mm (0.0078 inch) per side.
5. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
6. "L" is the length of terminal for soldering to a substrate.
7. "N" is the number of terminal positions.
8. Terminal numbers are shown for reference only.
9. Dimension "B" does not include dambar protrusion. Allowable dambar protrusion shall be 0.13mm (0.005 inch) total in excess of "B" dimension at maximum material condition.
10. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.

### M16.209 (JEDEC MO-150-AC ISSUE B) 16 LEAD SHRINK SMALL OUTLINE PLASTIC PACKAGE

| SYMBOL | INCHES    |       | MILLIMETERS |      | NOTES |
|--------|-----------|-------|-------------|------|-------|
|        | MIN       | MAX   | MIN         | MAX  |       |
| A      | -         | 0.078 | -           | 2.00 | -     |
| A1     | 0.002     | -     | 0.05        | -    | -     |
| A2     | 0.065     | 0.072 | 1.65        | 1.85 | -     |
| B      | 0.009     | 0.014 | 0.22        | 0.38 | 9     |
| C      | 0.004     | 0.009 | 0.09        | 0.25 | -     |
| D      | 0.233     | 0.255 | 5.90        | 6.50 | 3     |
| E      | 0.197     | 0.220 | 5.00        | 5.60 | 4     |
| e      | 0.026 BSC |       | 0.65 BSC    |      | -     |
| H      | 0.292     | 0.322 | 7.40        | 8.20 | -     |
| L      | 0.022     | 0.037 | 0.55        | 0.95 | 6     |
| N      | 16        |       | 16          |      | 7     |
| α      | 0°        | 8°    | 0°          | 8°   | -     |

Rev. 3 6/05

## Small Outline Plastic Packages (SOIC)



### NOTES:

1. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication Number 95.
2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
3. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
4. Dimension "E" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25mm (0.010 inch) per side.
5. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
6. "L" is the length of terminal for soldering to a substrate.
7. "N" is the number of terminal positions.
8. Terminal numbers are shown for reference only.
9. The lead width "B", as measured 0.36mm (0.014 inch) or greater above the seating plane, shall not exceed a maximum value of 0.61mm (0.024 inch)
10. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.

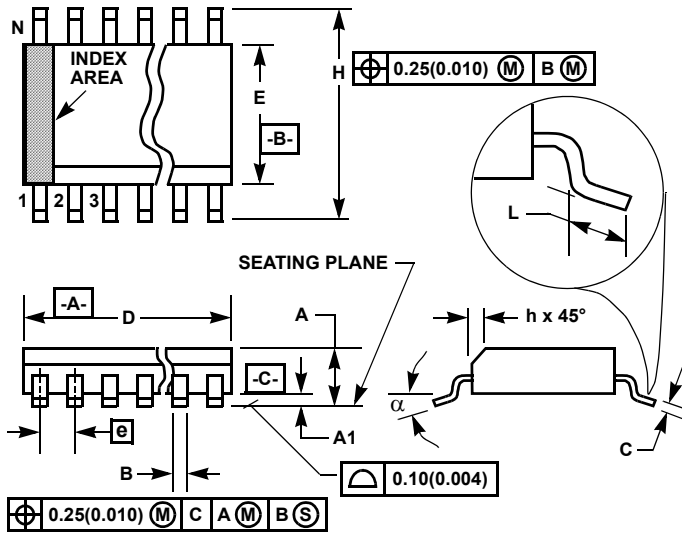
### M16.3 (JEDEC MS-013-AA ISSUE C)

#### 16 LEAD WIDE BODY SMALL OUTLINE PLASTIC PACKAGE

| SYMBOL   | INCHES    |        | MILLIMETERS |       | NOTES |
|----------|-----------|--------|-------------|-------|-------|
|          | MIN       | MAX    | MIN         | MAX   |       |
| A        | 0.0926    | 0.1043 | 2.35        | 2.65  | -     |
| A1       | 0.0040    | 0.0118 | 0.10        | 0.30  | -     |
| B        | 0.013     | 0.0200 | 0.33        | 0.51  | 9     |
| C        | 0.0091    | 0.0125 | 0.23        | 0.32  | -     |
| D        | 0.3977    | 0.4133 | 10.10       | 10.50 | 3     |
| E        | 0.2914    | 0.2992 | 7.40        | 7.60  | 4     |
| e        | 0.050 BSC |        | 1.27 BSC    |       | -     |
| H        | 0.394     | 0.419  | 10.00       | 10.65 | -     |
| h        | 0.010     | 0.029  | 0.25        | 0.75  | 5     |
| L        | 0.016     | 0.050  | 0.40        | 1.27  | 6     |
| N        | 16        |        | 16          |       | 7     |
| $\alpha$ | 0°        | 8°     | 0°          | 8°    | -     |

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## Small Outline Plastic Packages (SOIC)



### NOTES:

1. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication Number 95.
2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
3. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
4. Dimension "E" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25mm (0.010 inch) per side.
5. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
6. "L" is the length of terminal for soldering to a substrate.
7. "N" is the number of terminal positions.
8. Terminal numbers are shown for reference only.
9. The lead width "B", as measured 0.36mm (0.014 inch) or greater above the seating plane, shall not exceed a maximum value of 0.61mm (0.024 inch)
10. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.

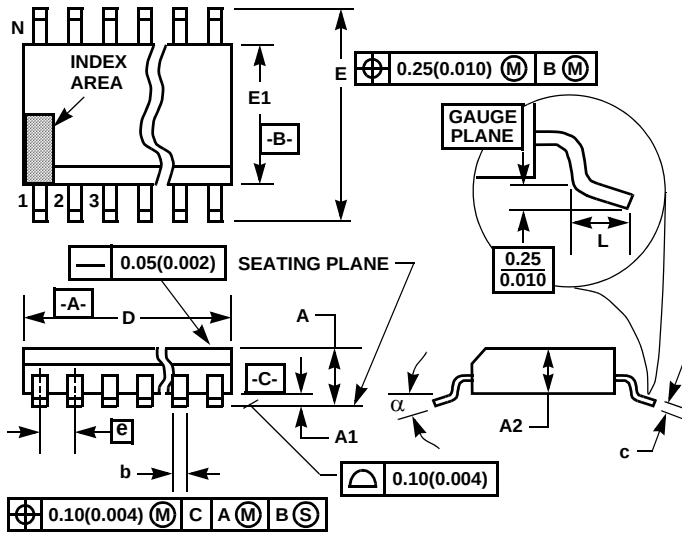
### M18.3 (JEDEC MS-013-AB ISSUE C)

#### 18 LEAD WIDE BODY SMALL OUTLINE PLASTIC PACKAGE

| SYMBOL   | INCHES    |        | MILLIMETERS |       | NOTES |
|----------|-----------|--------|-------------|-------|-------|
|          | MIN       | MAX    | MIN         | MAX   |       |
| A        | 0.0926    | 0.1043 | 2.35        | 2.65  | -     |
| A1       | 0.0040    | 0.0118 | 0.10        | 0.30  | -     |
| B        | 0.013     | 0.0200 | 0.33        | 0.51  | 9     |
| C        | 0.0091    | 0.0125 | 0.23        | 0.32  | -     |
| D        | 0.4469    | 0.4625 | 11.35       | 11.75 | 3     |
| E        | 0.2914    | 0.2992 | 7.40        | 7.60  | 4     |
| e        | 0.050 BSC |        | 1.27 BSC    |       | -     |
| H        | 0.394     | 0.419  | 10.00       | 10.65 | -     |
| h        | 0.010     | 0.029  | 0.25        | 0.75  | 5     |
| L        | 0.016     | 0.050  | 0.40        | 1.27  | 6     |
| N        | 18        |        | 18          |       | 7     |
| $\alpha$ | 0°        | 8°     | 0°          | 8°    | -     |

Rev. 1 6/05

# Thin Shrink Small Outline Plastic Packages (TSSOP)



## NOTES:

- These package dimensions are within allowable dimensions of JEDEC MO-153-AC, Issue E.
- Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
- Dimension "E1" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.15mm (0.006 inch) per side.
- The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
- "L" is the length of terminal for soldering to a substrate.
- "N" is the number of terminal positions.
- Terminal numbers are shown for reference only.
- Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.08mm (0.003 inch) total in excess of "b" dimension at maximum material condition. Minimum space between protrusion and adjacent lead is 0.07mm (0.0027 inch).
- Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact. (Angles in degrees)

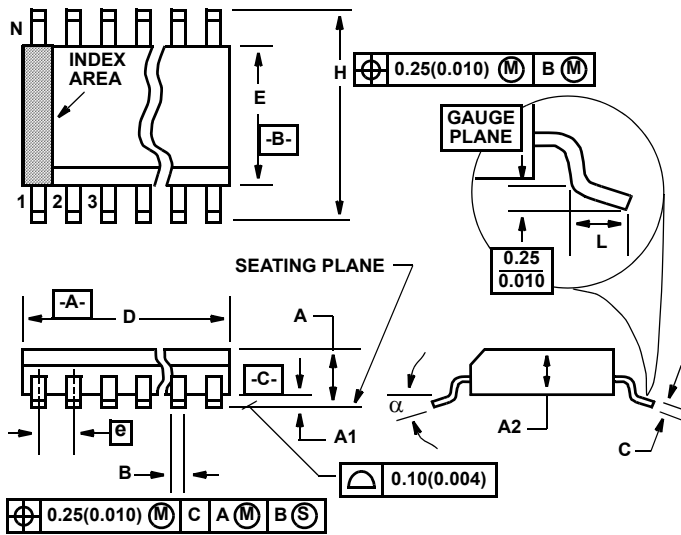
## M20.173

### 20 LEAD THIN SHRINK SMALL OUTLINE PLASTIC PACKAGE

| SYMBOL   | INCHES    |        | MILLIMETERS |      | NOTES |
|----------|-----------|--------|-------------|------|-------|
|          | MIN       | MAX    | MIN         | MAX  |       |
| A        | -         | 0.047  | -           | 1.20 | -     |
| A1       | 0.002     | 0.006  | 0.05        | 0.15 | -     |
| A2       | 0.031     | 0.051  | 0.80        | 1.05 | -     |
| b        | 0.0075    | 0.0118 | 0.19        | 0.30 | 9     |
| c        | 0.0035    | 0.0079 | 0.09        | 0.20 | -     |
| D        | 0.252     | 0.260  | 6.40        | 6.60 | 3     |
| E1       | 0.169     | 0.177  | 4.30        | 4.50 | 4     |
| e        | 0.026 BSC |        | 0.65 BSC    |      | -     |
| E        | 0.246     | 0.256  | 6.25        | 6.50 | -     |
| L        | 0.0177    | 0.0295 | 0.45        | 0.75 | 6     |
| N        | 20        |        | 20          |      | 7     |
| $\alpha$ | 0°        | 8°     | 0°          | 8°   | -     |

Rev. 1 6/98

## Shrink Small Outline Plastic Packages (SSOP)



### M20.209 (JEDEC MO-150-AE ISSUE B) 20 LEAD SHRINK SMALL OUTLINE PLASTIC PACKAGE

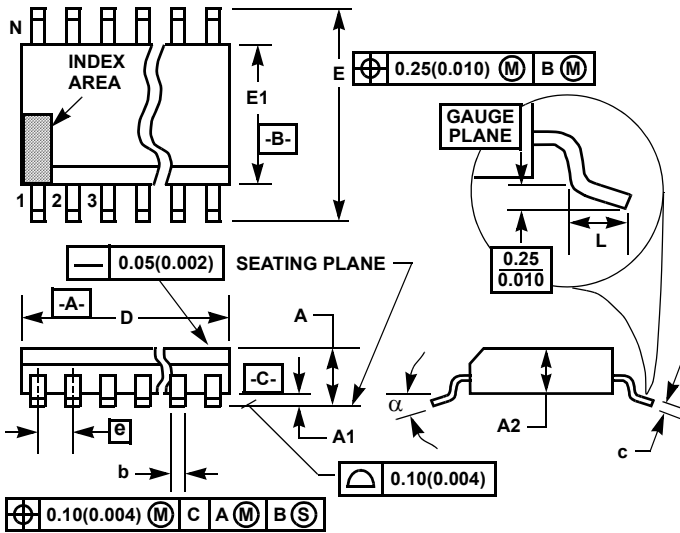
| SYMBOL   | INCHES    |        | MILLIMETERS |        | NOTES |
|----------|-----------|--------|-------------|--------|-------|
|          | MIN       | MAX    | MIN         | MAX    |       |
| A        | 0.068     | 0.078  | 1.73        | 1.99   |       |
| A1       | 0.002     | 0.008  | 0.05        | 0.21   |       |
| A2       | 0.066     | 0.070  | 1.68        | 1.78   |       |
| B        | 0.010     | 0.015  | 0.25        | 0.38   | 9     |
| C        | 0.004     | 0.008  | 0.09        | 0.20   |       |
| D        | 0.278     | 0.289  | 7.07        | 7.33   | 3     |
| E        | 0.205     | 0.212  | 5.20        | 5.38   | 4     |
| e        | 0.026 BSC |        | 0.65 BSC    |        |       |
| H        | 0.301     | 0.311  | 7.65        | 7.90   |       |
| L        | 0.025     | 0.037  | 0.63        | 0.95   | 6     |
| N        | 20        |        | 20          |        | 7     |
| $\alpha$ | 0 deg.    | 8 deg. | 0 deg.      | 8 deg. |       |

Rev. 3 11/02

#### NOTES:

- Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication Number 95.
- Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.20mm (0.0078 inch) per side.
- Dimension "E" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.20mm (0.0078 inch) per side.
- The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
- "L" is the length of terminal for soldering to a substrate.
- "N" is the number of terminal positions.
- Terminal numbers are shown for reference only.
- Dimension "B" does not include dambar protrusion. Allowable dambar protrusion shall be 0.13mm (0.005 inch) total in excess of "B" dimension at maximum material condition.
- Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.

# Thin Shrink Small Outline Plastic Packages (TSSOP)



## M28.173

### 28 LEAD THIN SHRINK SMALL OUTLINE PLASTIC PACKAGE

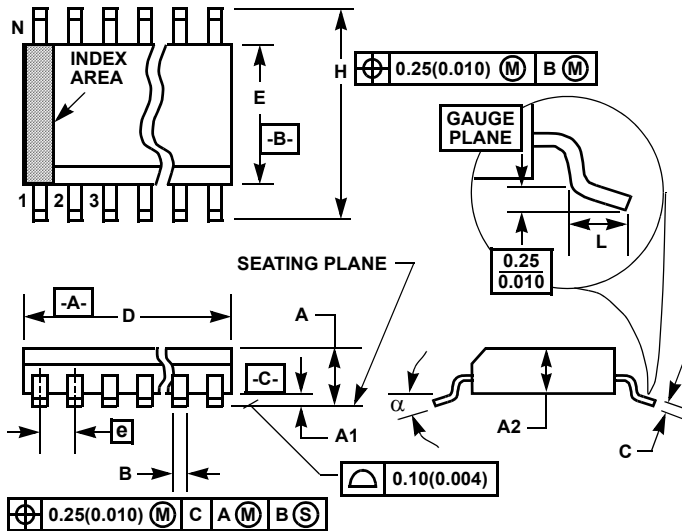
| SYMBOL   | INCHES    |        | MILLIMETERS |      | NOTES |
|----------|-----------|--------|-------------|------|-------|
|          | MIN       | MAX    | MIN         | MAX  |       |
| A        | -         | 0.047  | -           | 1.20 | -     |
| A1       | 0.002     | 0.006  | 0.05        | 0.15 | -     |
| A2       | 0.031     | 0.051  | 0.80        | 1.05 | -     |
| b        | 0.0075    | 0.0118 | 0.19        | 0.30 | 9     |
| c        | 0.0035    | 0.0079 | 0.09        | 0.20 | -     |
| D        | 0.378     | 0.386  | 9.60        | 9.80 | 3     |
| E1       | 0.169     | 0.177  | 4.30        | 4.50 | 4     |
| e        | 0.026 BSC |        | 0.65 BSC    |      | -     |
| E        | 0.246     | 0.256  | 6.25        | 6.50 | -     |
| L        | 0.0177    | 0.0295 | 0.45        | 0.75 | 6     |
| N        | 28        |        | 28          |      | 7     |
| $\alpha$ | 0°        | 8°     | 0°          | 8°   | -     |

Rev. 0 6/98

#### NOTES:

- These package dimensions are within allowable dimensions of JEDEC MO-153-AE, Issue E.
- Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
- Dimension "E1" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.15mm (0.006 inch) per side.
- The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
- "L" is the length of terminal for soldering to a substrate.
- "N" is the number of terminal positions.
- Terminal numbers are shown for reference only.
- Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.08mm (0.003 inch) total in excess of "b" dimension at maximum material condition. Minimum space between protrusion and adjacent lead is 0.07mm (0.0027 inch).
- Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact. (Angles in degrees)

## Shrink Small Outline Plastic Packages (SSOP)



### NOTES:

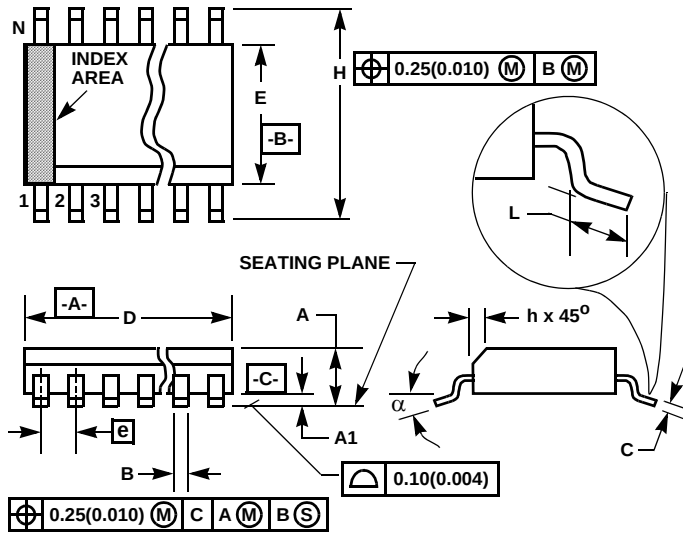
- Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication Number 95.
- Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.20mm (0.0078 inch) per side.
- Dimension "E" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.20mm (0.0078 inch) per side.
- The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
- "L" is the length of terminal for soldering to a substrate.
- "N" is the number of terminal positions.
- Terminal numbers are shown for reference only.
- Dimension "B" does not include dambar protrusion. Allowable dambar protrusion shall be 0.13mm (0.005 inch) total in excess of "B" dimension at maximum material condition.
- Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.

### M28.209 (JEDEC MO-150-AH ISSUE B) 28 LEAD SHRINK SMALL OUTLINE PLASTIC PACKAGE

| SYMBOL   | INCHES    |       | MILLIMETERS |       | NOTES |
|----------|-----------|-------|-------------|-------|-------|
|          | MIN       | MAX   | MIN         | MAX   |       |
| A        | -         | 0.078 | -           | 2.00  | -     |
| A1       | 0.002     | -     | 0.05        | -     | -     |
| A2       | 0.065     | 0.072 | 1.65        | 1.85  | -     |
| B        | 0.009     | 0.014 | 0.22        | 0.38  | 9     |
| C        | 0.004     | 0.009 | 0.09        | 0.25  | -     |
| D        | 0.390     | 0.413 | 9.90        | 10.50 | 3     |
| E        | 0.197     | 0.220 | 5.00        | 5.60  | 4     |
| e        | 0.026 BSC |       | 0.65 BSC    |       | -     |
| H        | 0.292     | 0.322 | 7.40        | 8.20  | -     |
| L        | 0.022     | 0.037 | 0.55        | 0.95  | 6     |
| N        | 28        |       | 28          |       | 7     |
| $\alpha$ | 0°        | 8°    | 0°          | 8°    | -     |

Rev. 2 6/05

## Small Outline Plastic Packages (SOIC)



### NOTES:

- Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication Number 95.
- Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
- Dimension "E" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25mm (0.010 inch) per side.
- The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
- "L" is the length of terminal for soldering to a substrate.
- "N" is the number of terminal positions.
- Terminal numbers are shown for reference only.
- The lead width "B", as measured 0.36mm (0.014 inch) or greater above the seating plane, shall not exceed a maximum value of 0.61mm (0.024 inch)
- Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.

### M28.3 (JEDEC MS-013-AE ISSUE C)

#### 28 LEAD WIDE BODY SMALL OUTLINE PLASTIC PACKAGE

| SYMBOL | INCHES   |        | MILLIMETERS |       | NOTES |
|--------|----------|--------|-------------|-------|-------|
|        | MIN      | MAX    | MIN         | MAX   |       |
| A      | 0.0926   | 0.1043 | 2.35        | 2.65  | -     |
| A1     | 0.0040   | 0.0118 | 0.10        | 0.30  | -     |
| B      | 0.013    | 0.0200 | 0.33        | 0.51  | 9     |
| C      | 0.0091   | 0.0125 | 0.23        | 0.32  | -     |
| D      | 0.6969   | 0.7125 | 17.70       | 18.10 | 3     |
| E      | 0.2914   | 0.2992 | 7.40        | 7.60  | 4     |
| e      | 0.05 BSC |        | 1.27 BSC    |       | -     |
| H      | 0.394    | 0.419  | 10.00       | 10.65 | -     |
| h      | 0.01     | 0.029  | 0.25        | 0.75  | 5     |
| L      | 0.016    | 0.050  | 0.40        | 1.27  | 6     |
| N      | 28       |        | 28          |       | 7     |
| α      | 0°       | 8°     | 0°          | 8°    | -     |

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